

Analog Integrated Systems Design

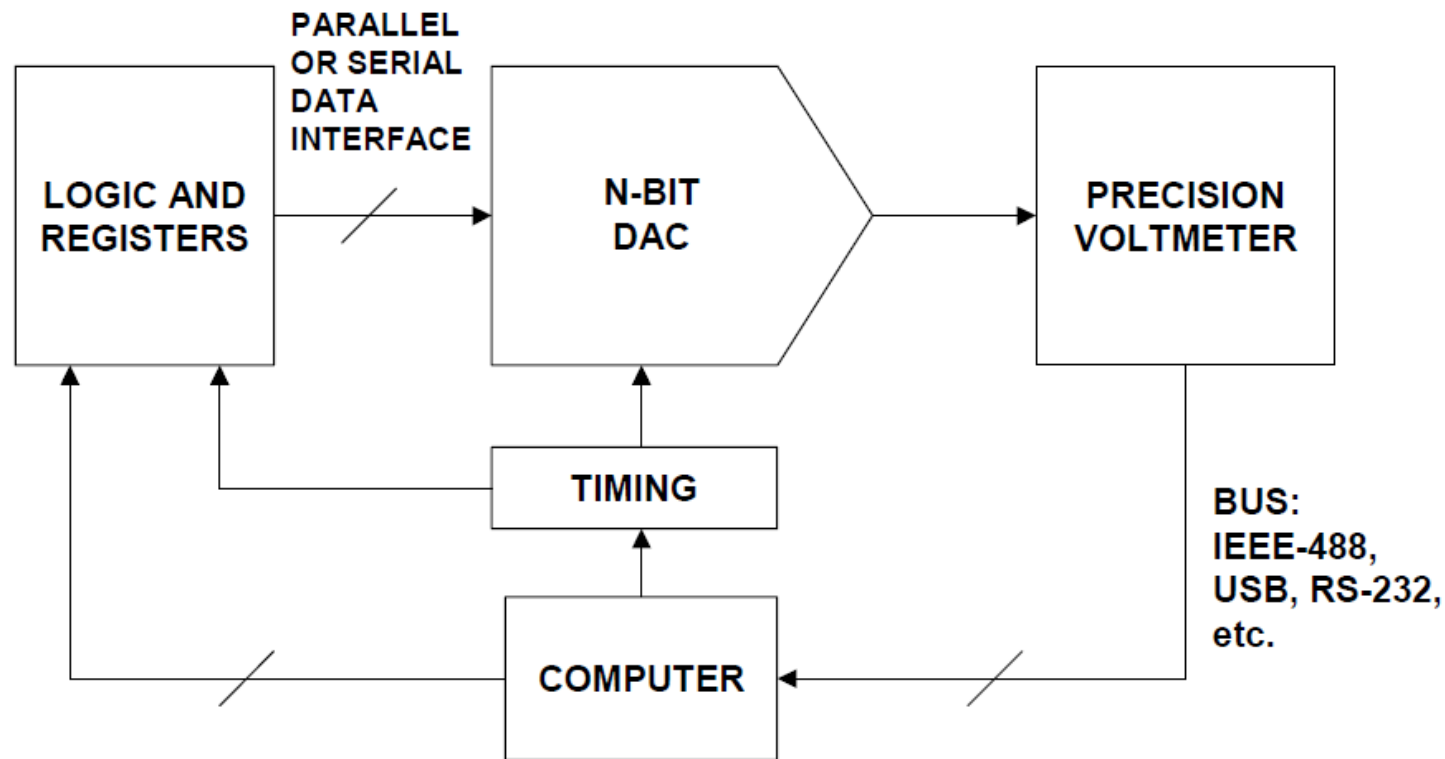
Lecture 06 Data Converters Testing

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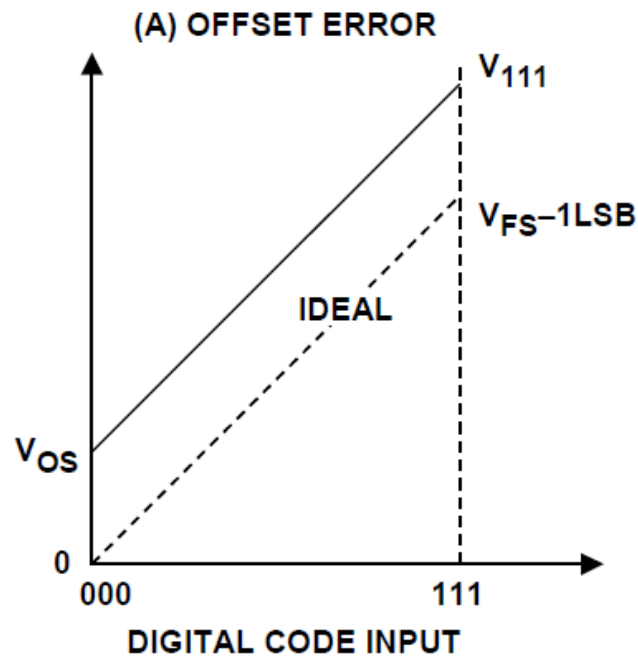
DAC Static Testing

- ❑ Many points to test!
- ❑ Use automated computer-based test setup (LabVIEW, MATLAB, etc.)
- ❑ Most equipment can be computer-controlled (GPIB, USB, etc.)

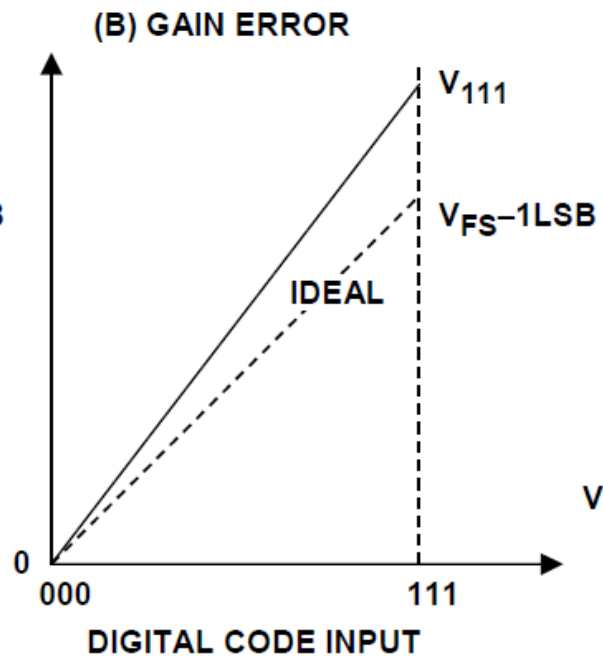


DAC Offset and Gain Errors

- Measure offset error first then measure gain error



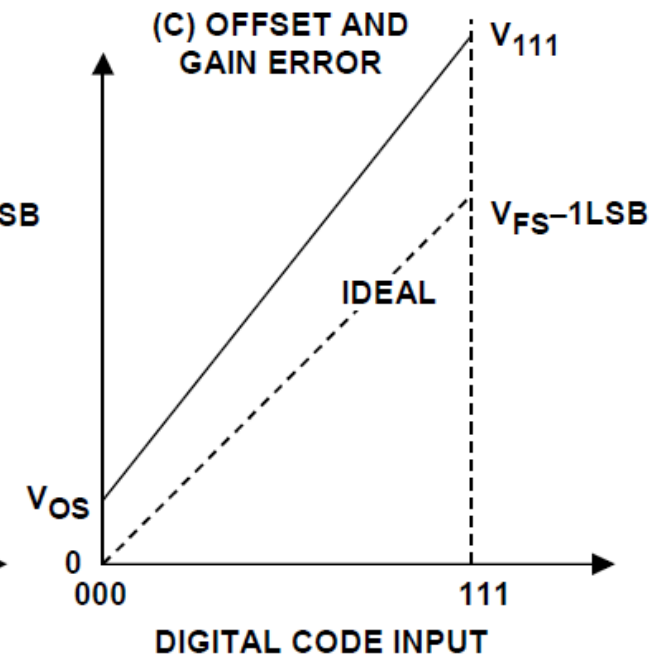
OFFSET ERROR = $V_{000} = V_{OS}$
GAIN ERROR = 0



OFFSET ERROR = 0

GAIN ERROR (%) =

$$100 \left[\frac{V_{111}}{V_{FS} - 1LSB} - 1 \right]$$



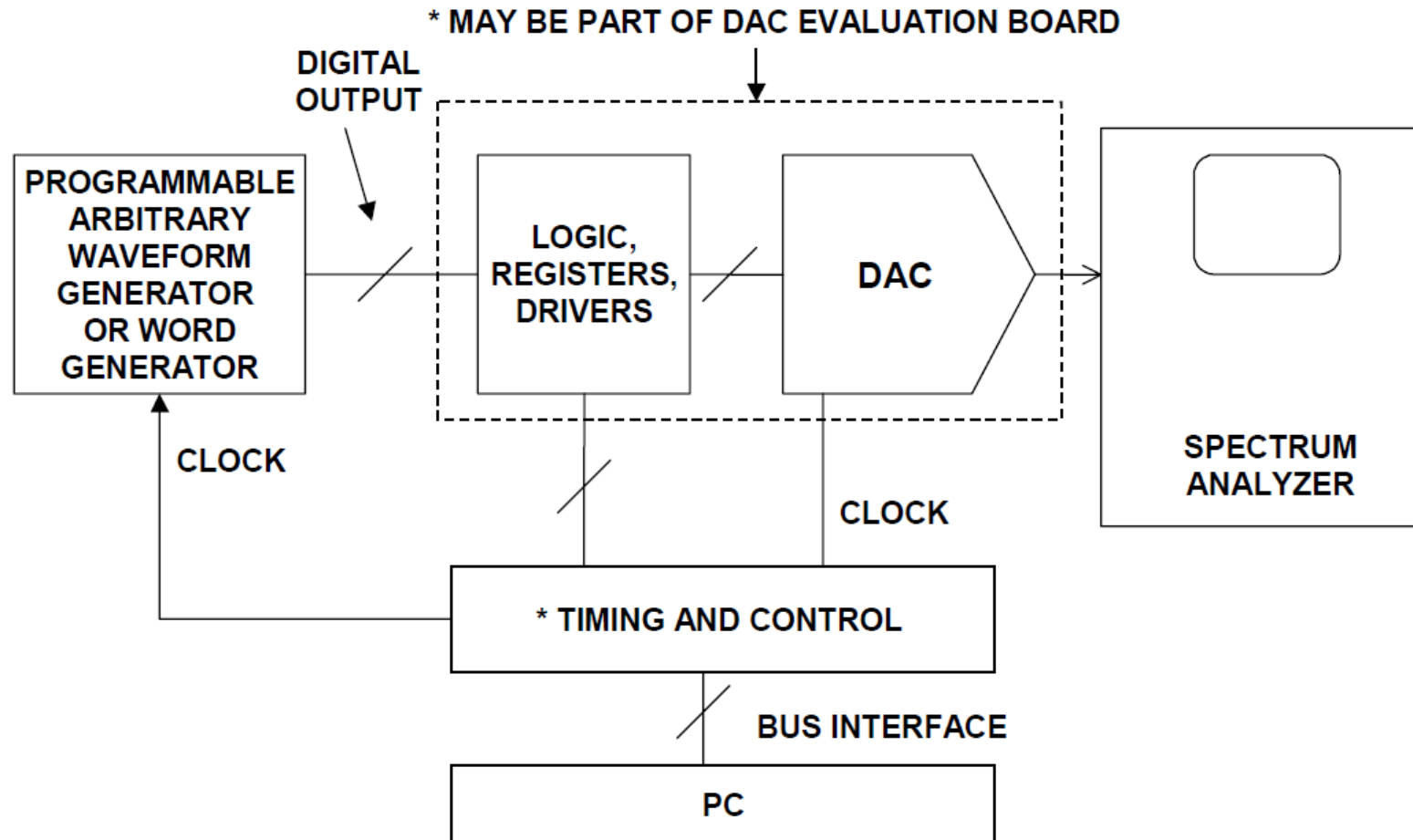
OFFSET ERROR = $V_{000} = V_{OS}$

GAIN ERROR (%) =

$$100 \left[\frac{V_{111} - V_{OS}}{V_{FS} - 1LSB} - 1 \right]$$

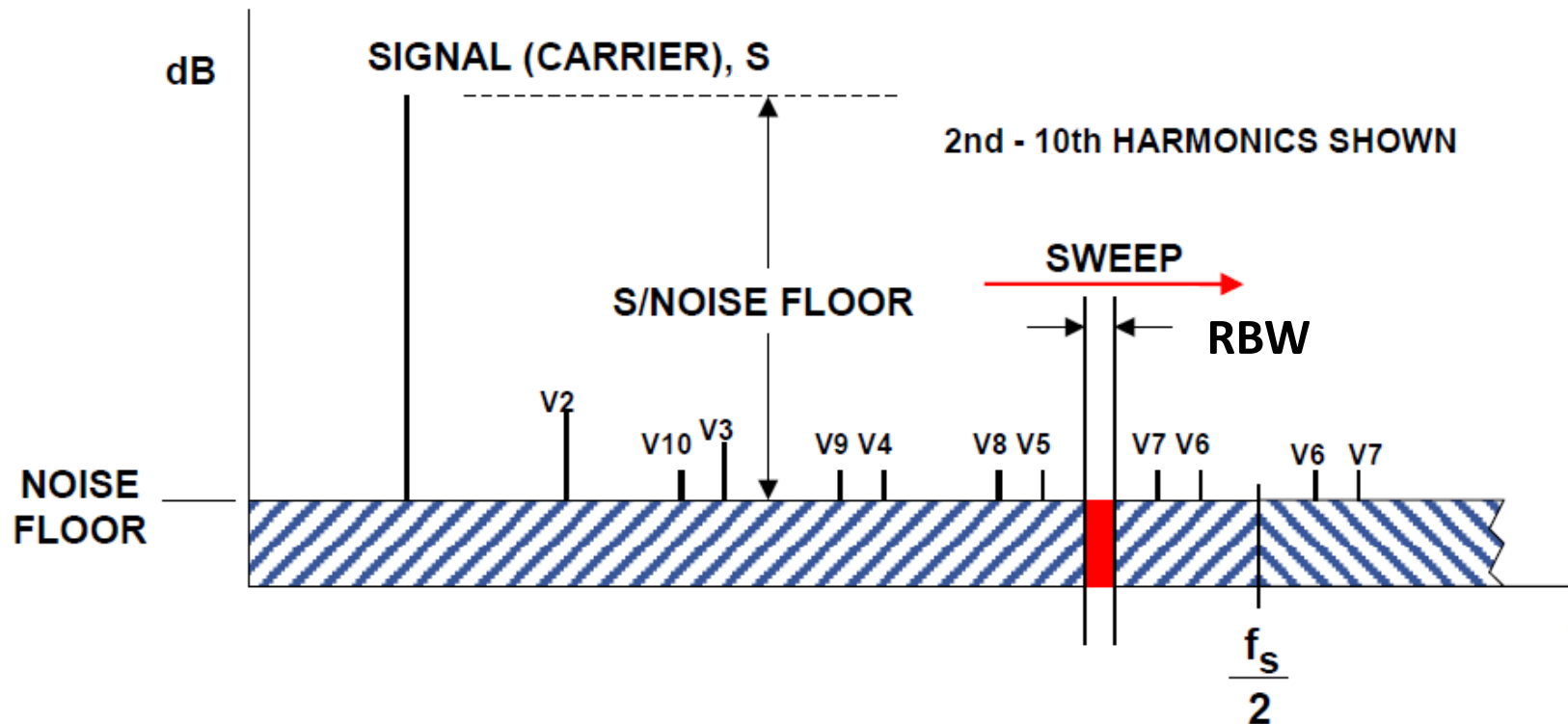
DAC Dynamic Testing

- ❑ Drive DAC by digital sine wave
- ❑ Plot analog output using spectrum analyzer



DAC Dynamic Testing

- Spectrum analyzer resolution bandwidth (RBW) is equivalent to FFT bin size



◆ **RBW = ANALYZER RESOLUTION BANDWIDTH**

◆
$$\text{SNR} = \text{S/NOISE FLOOR} - 10 \log_{10} \left[\frac{f_s/2}{\text{RBW}} \right]$$

DAC Dynamic Testing

$$\blacklozenge \text{ SNR} = \text{S/NOISE FLOOR} - 10 \log_{10} \left[\frac{f_s/2}{\text{RBW}} \right]$$

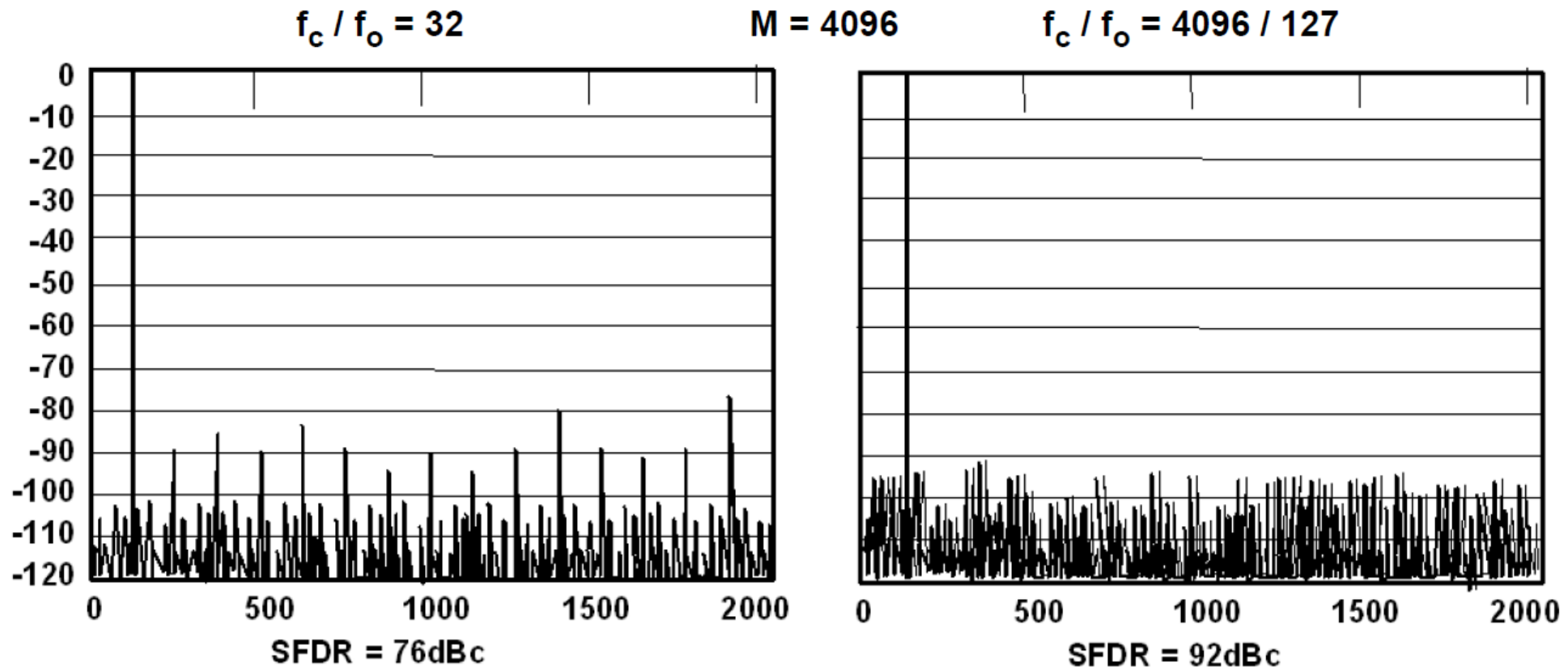
$$\blacklozenge \text{ THD} = 20 \log_{10} \sqrt{\left[10^{-V2/20} \right]^2 + \left[10^{-V3/20} \right]^2 + \dots + \left[10^{-V6/20} \right]^2}$$

$$\blacklozenge \text{ SINAD} = 20 \log_{10} \sqrt{\left[10^{-\text{SNR}/20} \right]^2 + \left[10^{-\text{THD}/20} \right]^2}$$

NOTE: NOISE FLOOR, SNR, THD, SINAD, V2, V3, ... , V6 in units of dBc

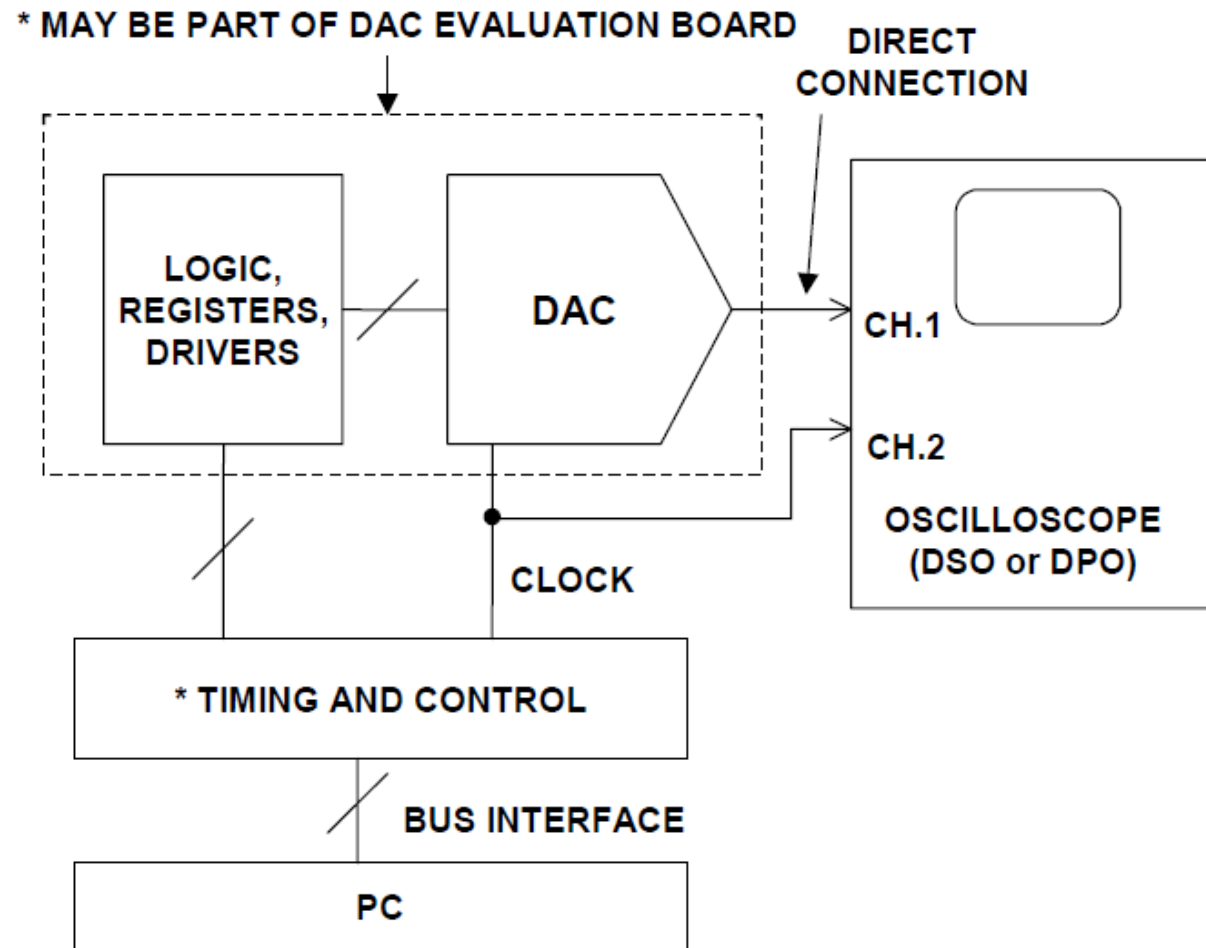
DAC Dynamic Testing

- ❑ The ratio of update rate to test tone frequency must be non-integer
 - Otherwise quantization noise will appear as distortion



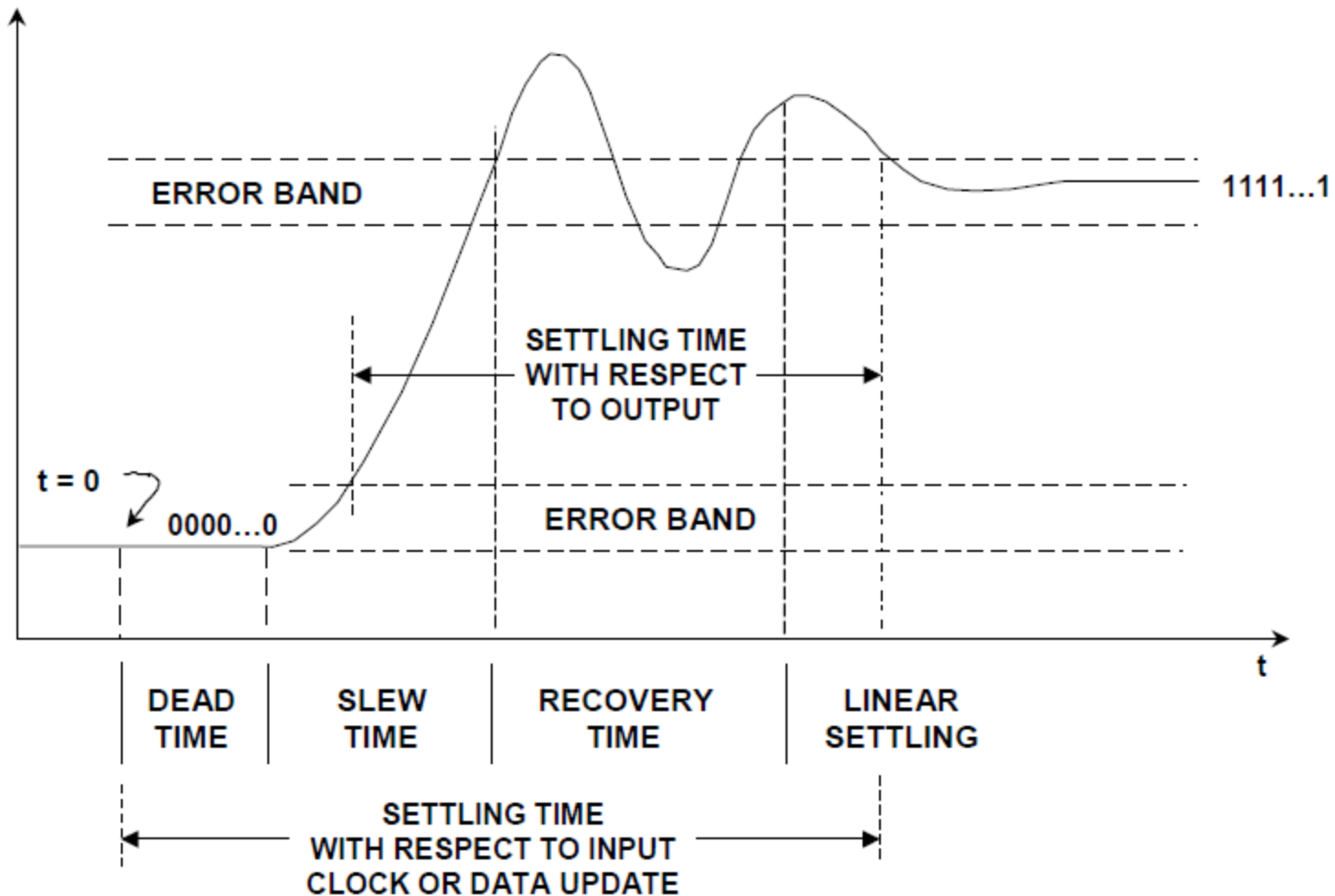
DAC Settling Time Testing

- ❑ Drive DAC by digital step
- ❑ Plot clock and output on oscilloscope



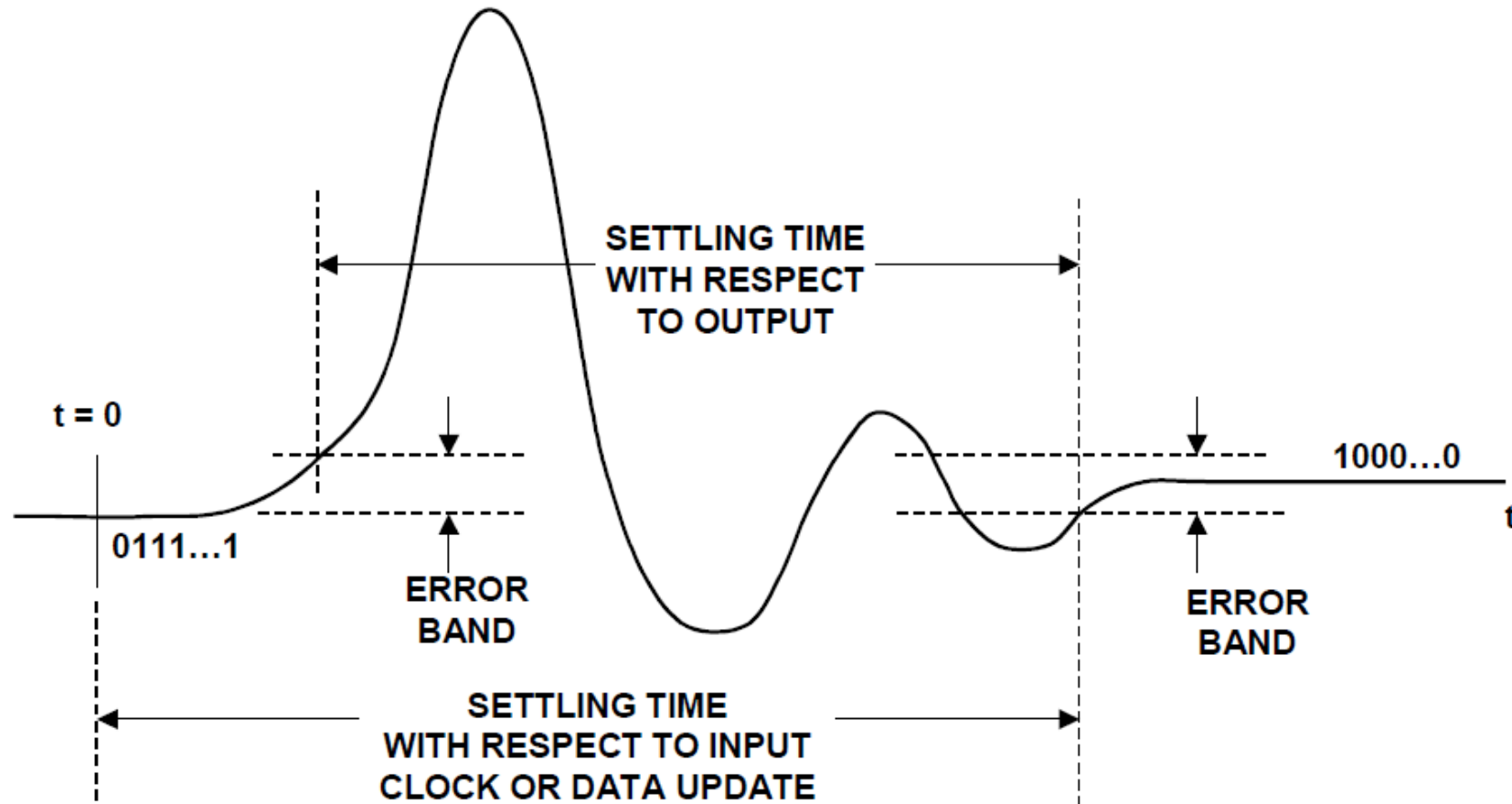
DAC Full-Scale Settling Time Testing

- Digital step from all 0s to all 1s



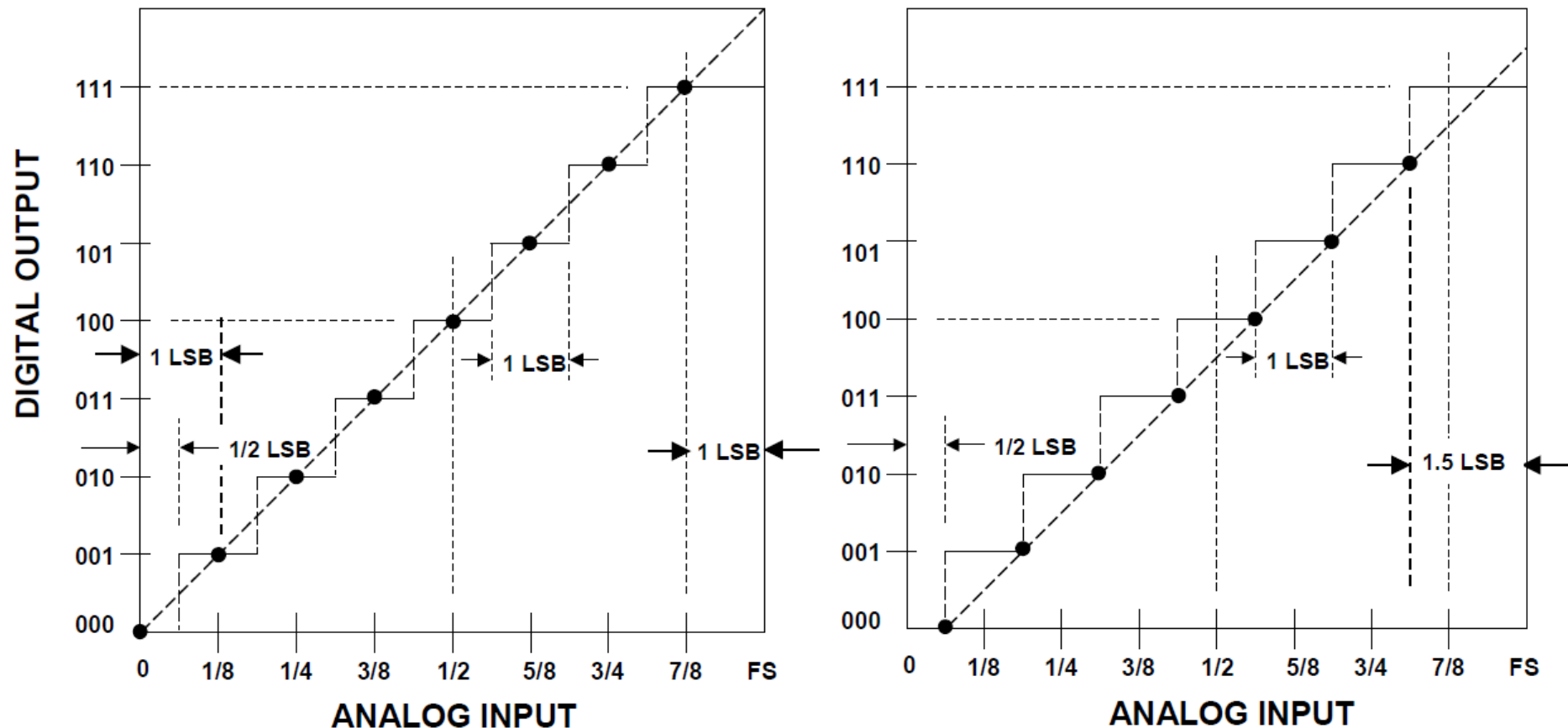
DAC Mid-Scale Settling Time Testing

- ❑ In midscale transition all bits are switched, but may not switch simultaneously

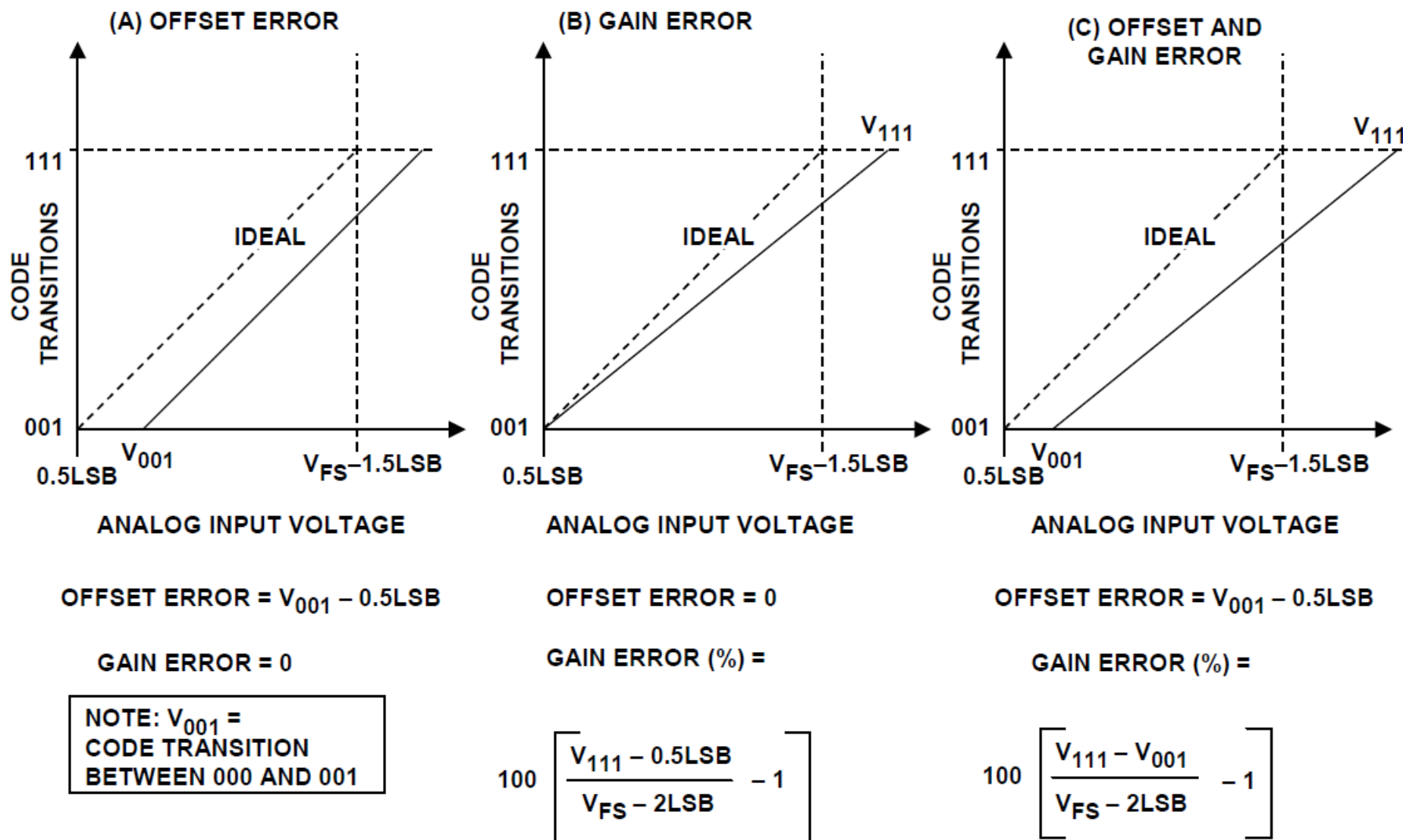


ADC Static Testing

- ❑ Code centers are difficult to measure → use code transitions
 - First point in the ccs (first code transition) at $V_{LSB}/2$
 - Last point in the ccs (last code transition) at $V_{FS} - 1.5V_{LSB}$

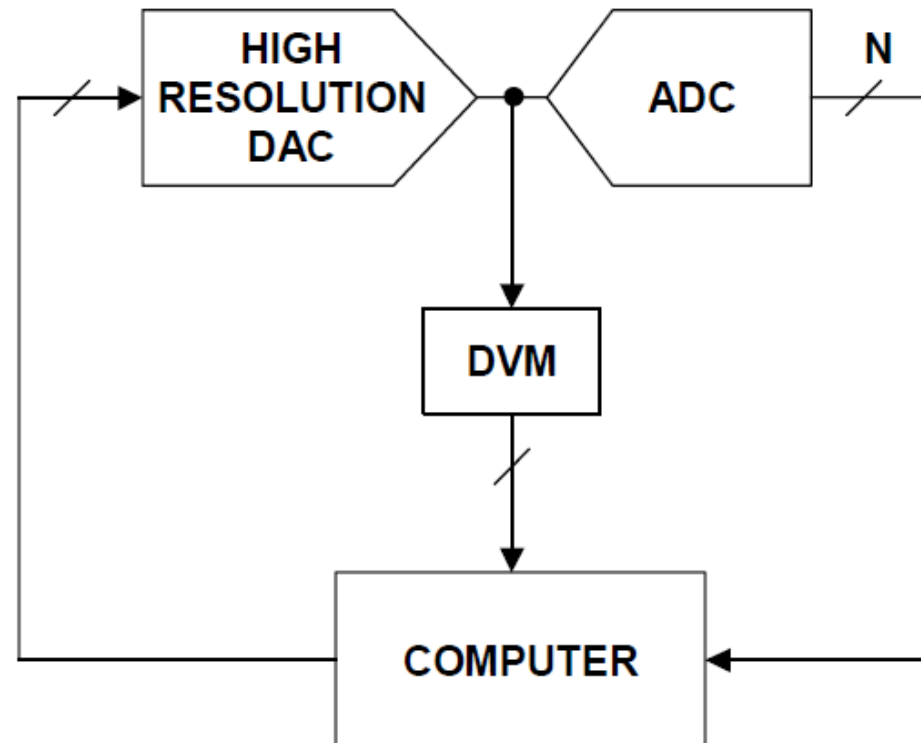


ADC Offset and Gain Errors

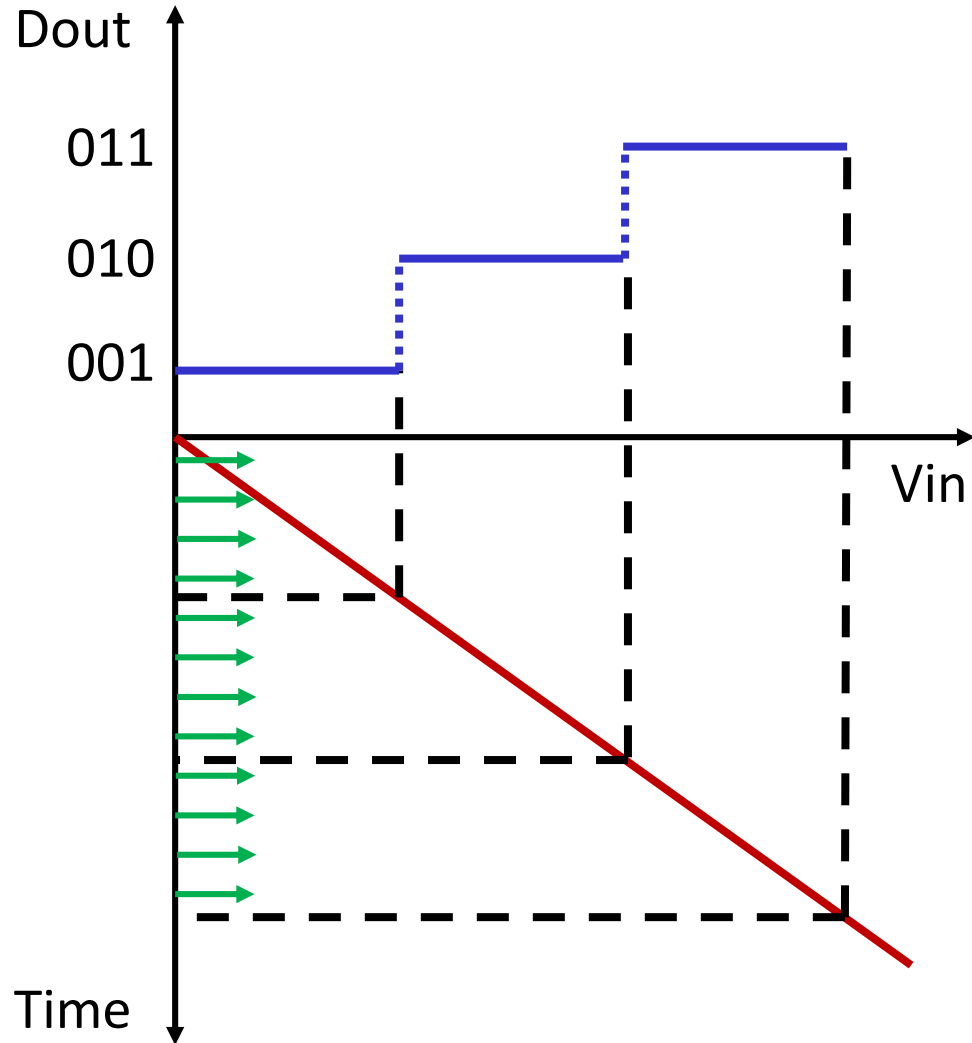


Servo-Loop Code Transition Test

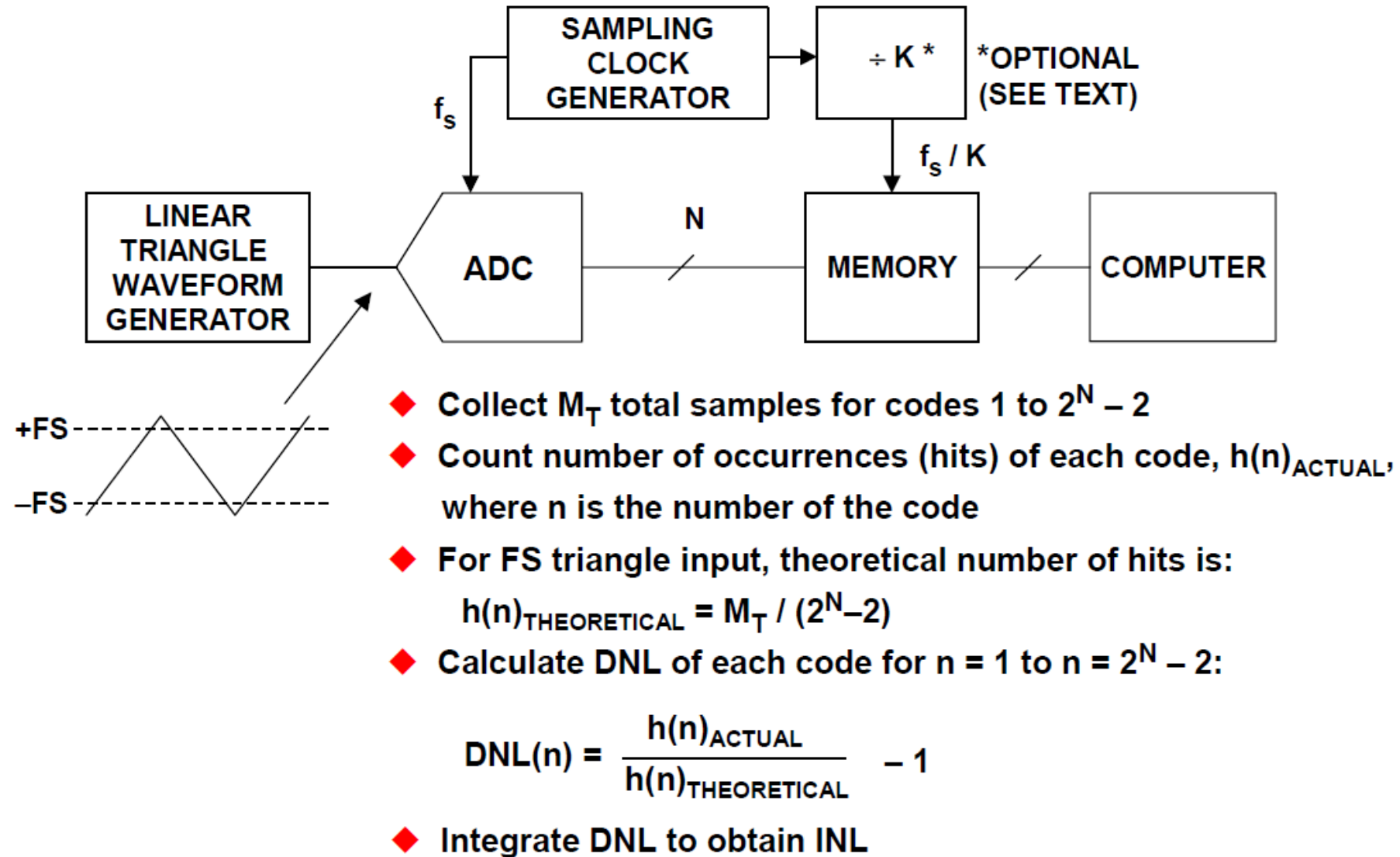
- ❑ Detect when ADC output code flips
 - Record DVM output → code transition
 - Use averaging to cancel ADC input-referred noise
- ❑ DAC resolution must be \geq ADC resolution + 2-bit



Histogram (Code Density) Test

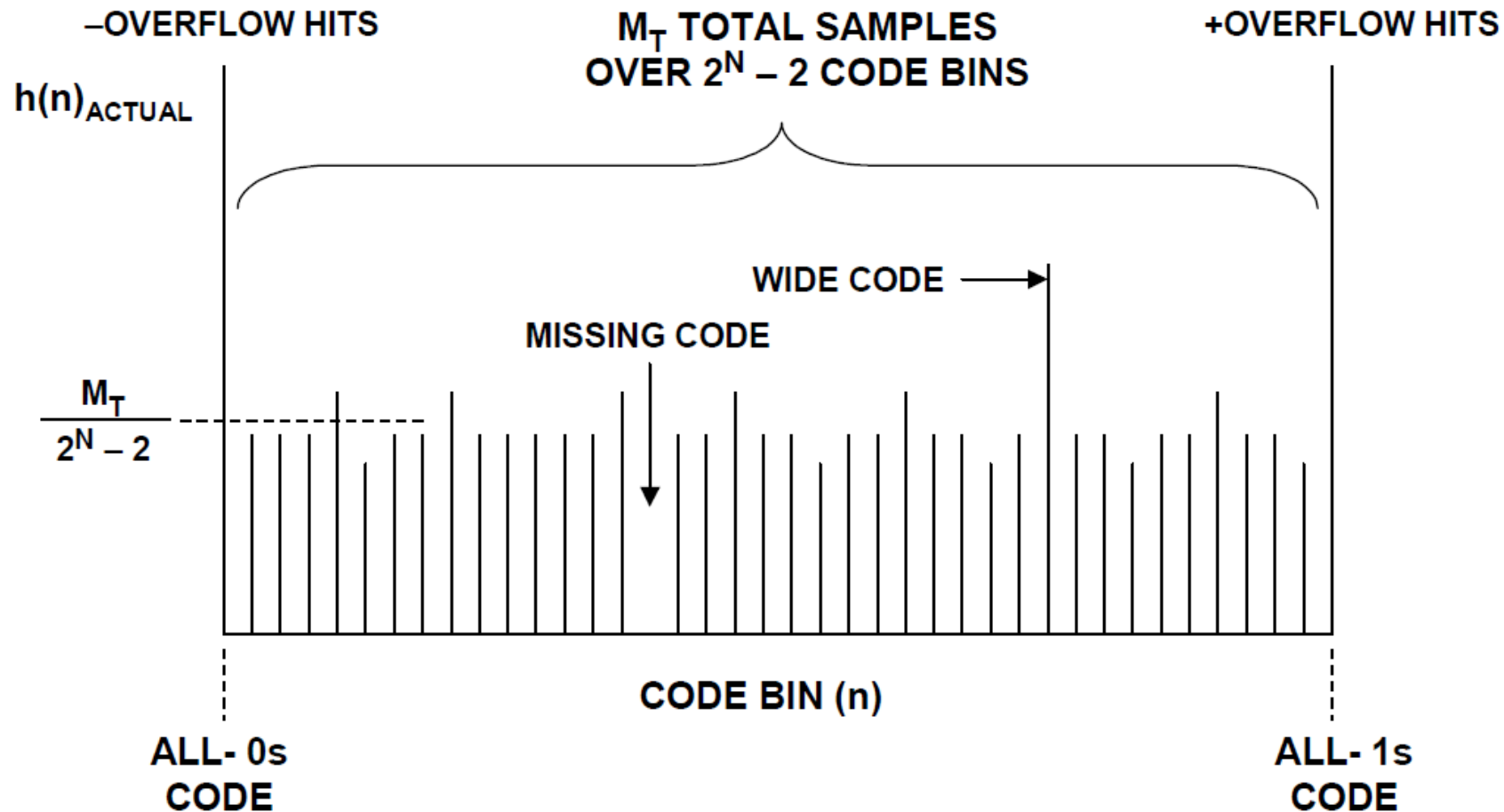


Histogram (Code Density) Test



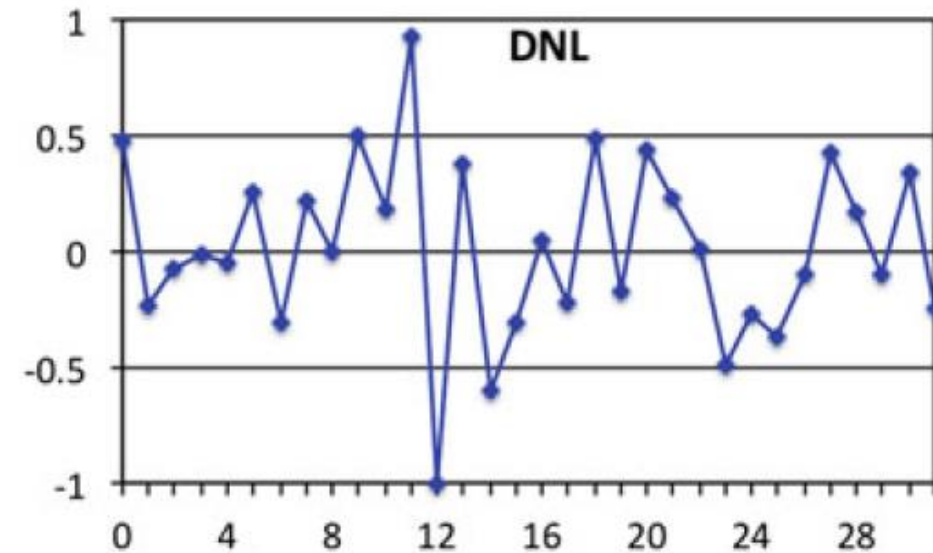
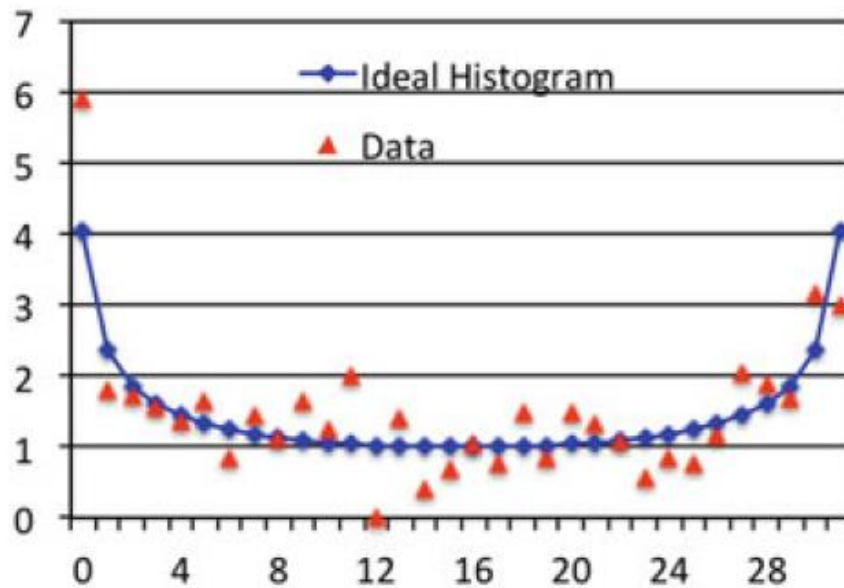
Histogram (Code Density) Test

- ❑ Overflow hits in all 0s and all 1s bins are discarded

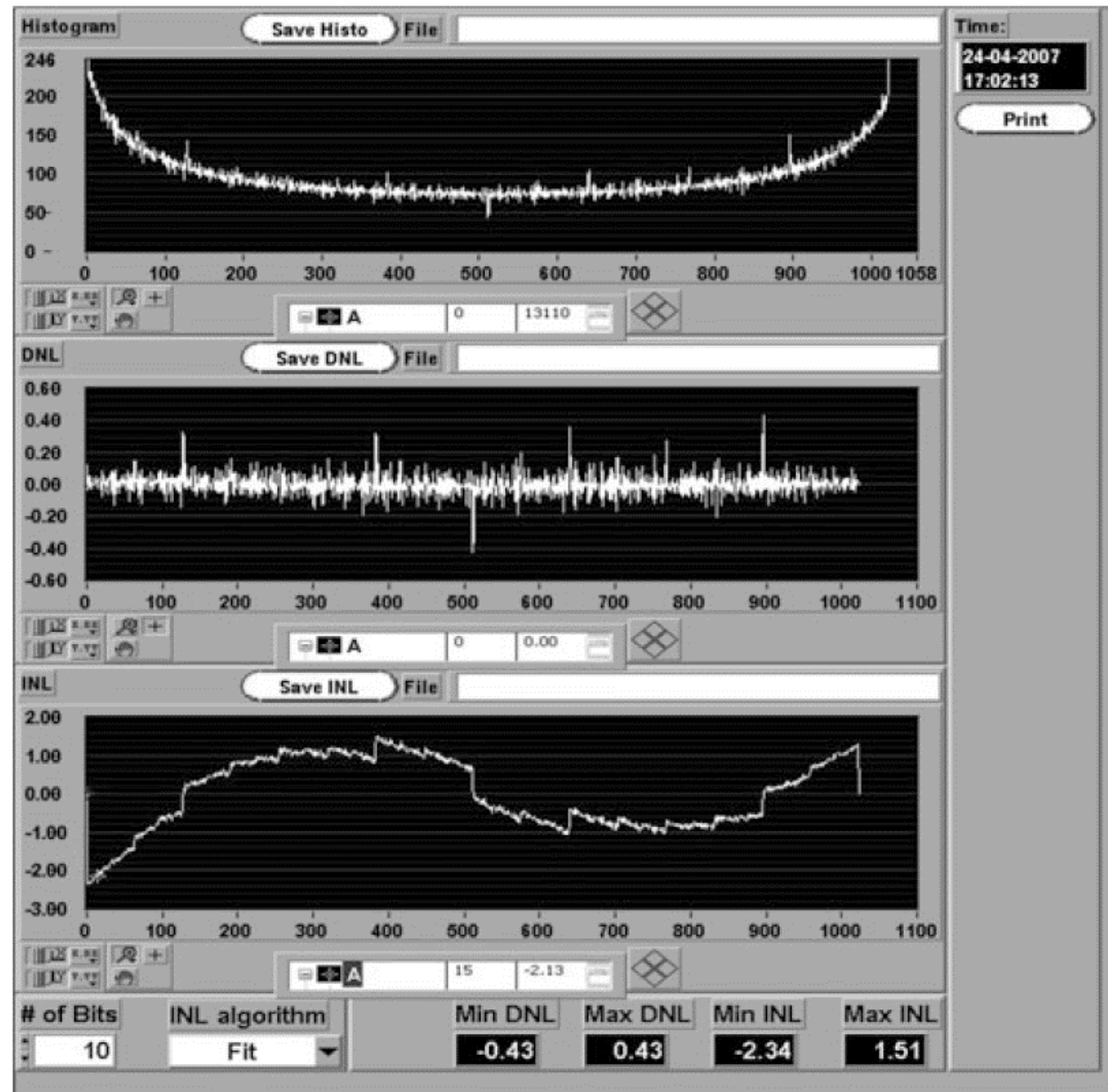


Sine Wave Histogram Test

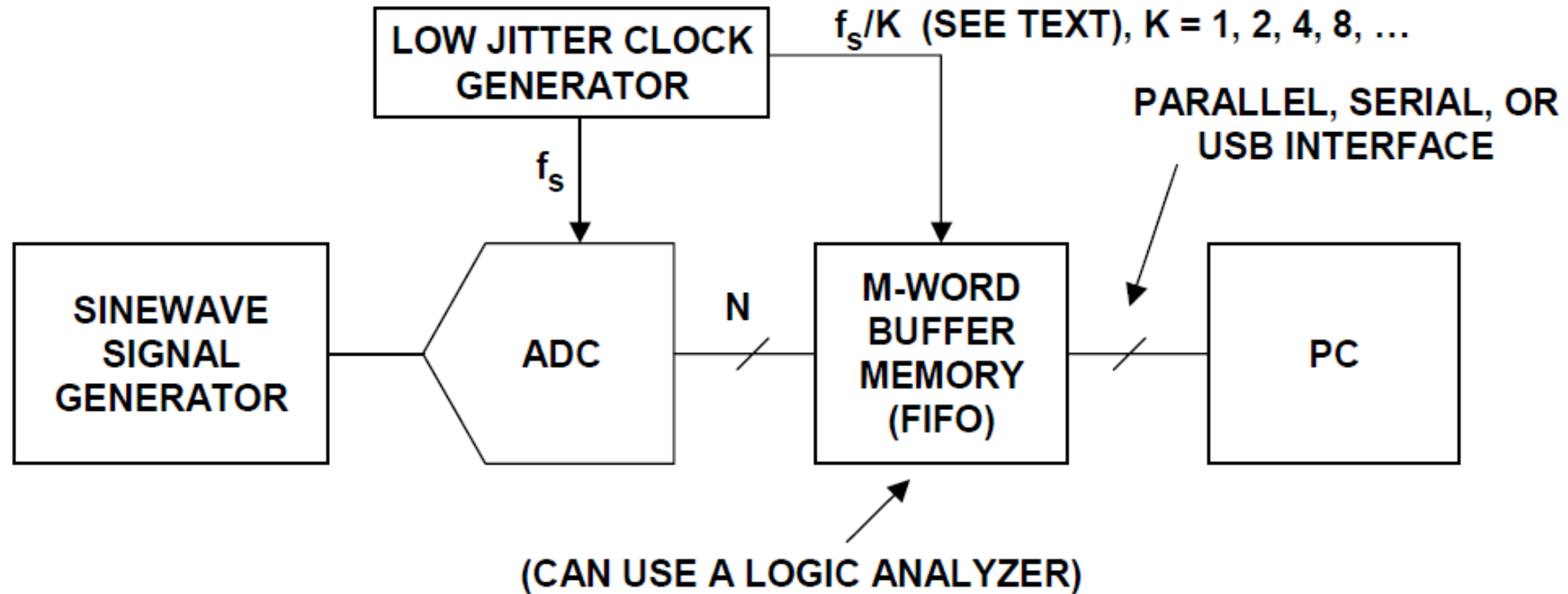
- ❑ Sinewaves can be generated with extremely high linearity and low noise with appropriate filtering
- ❑ Currently, the standard and most popular method to measure ADC static characteristics



Sine Wave Histogram Test Example

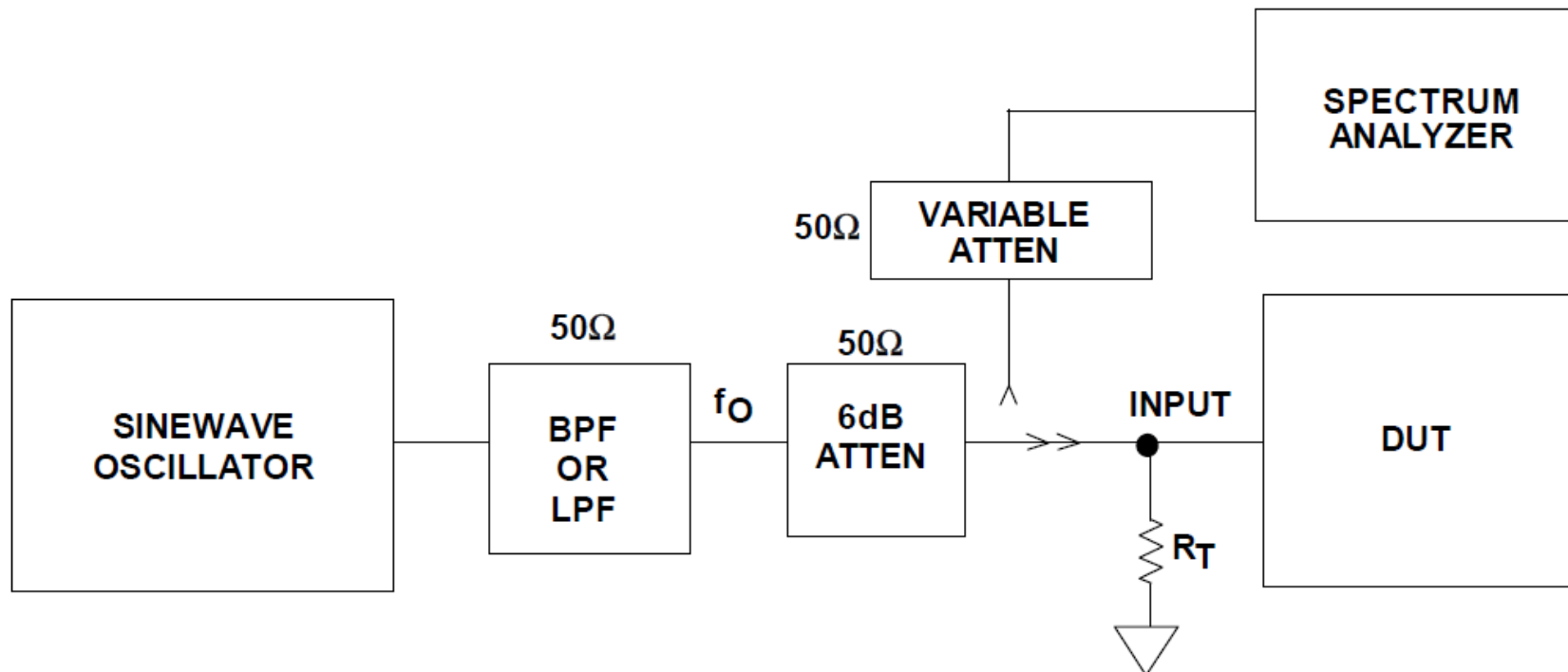


ADC Dynamic Testing



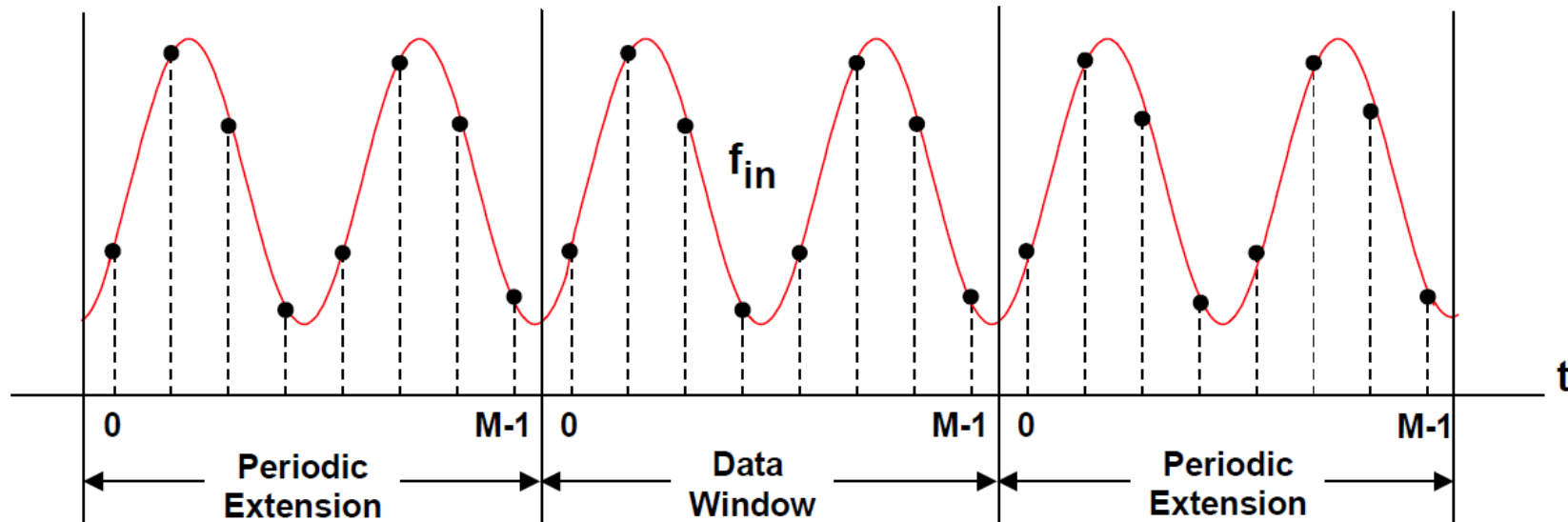
Generating Low Distortion Single Tone

- ❑ BPF or LPF is necessary to remove harmonics (Ex: tte.com)
- ❑ The input tone distortion should be 10 dB lower than the desired accuracy of the measurement
- ❑ R_T is selected so that the parallel combination of R_T and the input impedance of the DUT is $50\ \Omega$



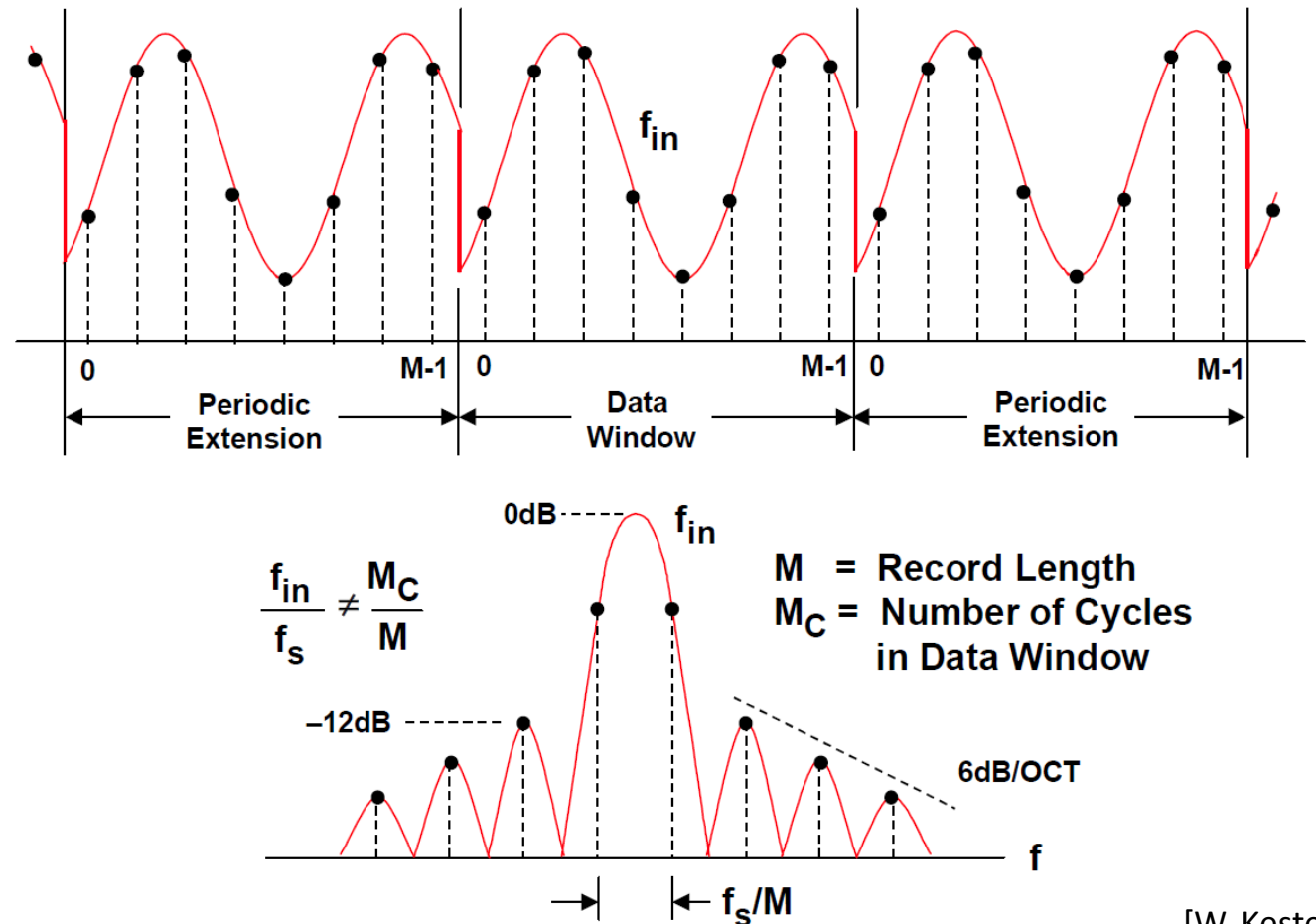
DTFS (DTFT) and FFT

- ❑ The DFT Operates on a Finite Number (M) of Digitized Time Samples
- ❑ When These Samples are Repeated and Placed “End-to-End”, they Appear Periodic to the Transform
- ❑ Practically, Fast Fourier Transform (FFT) is used to compute DFT
- ❑ The FFT is simply an algorithm that reduces the required number of mathematical computations



Spectral Leakage

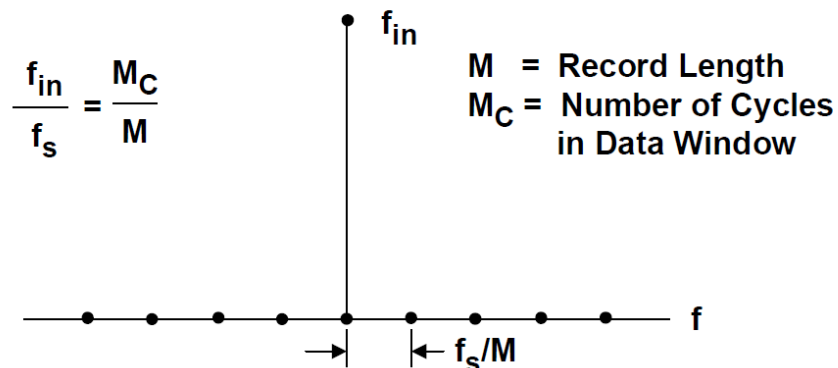
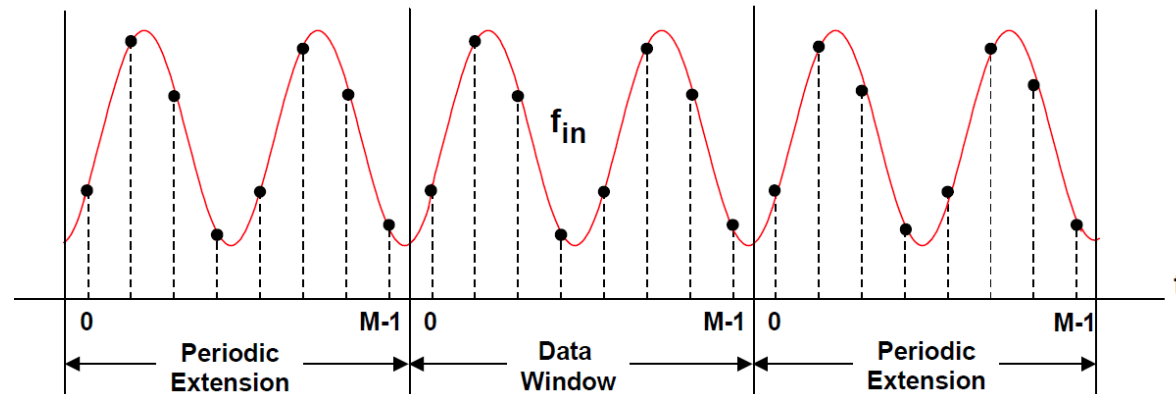
- ❑ The discontinuities at endpoints result in “spectral leakage”
- ❑ Equivalent to multiplying the input sinewave by a rectangular window pulse which has the familiar $\sin(x)/x$ frequency response



Coherent Testing Condition

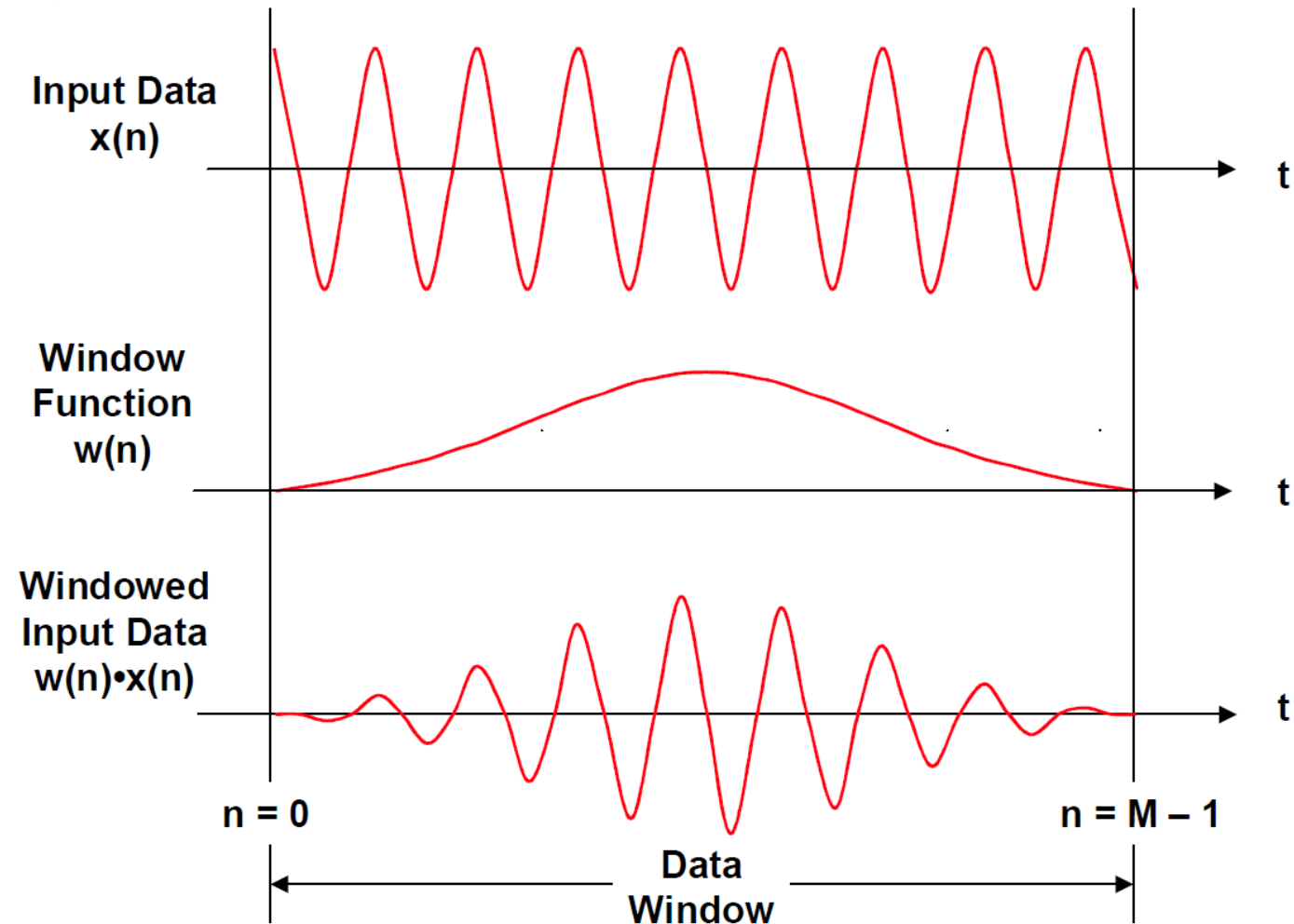
$$T_{measure} = M \times T_s = M_C \times T_{in} \Rightarrow \frac{f_s}{f_{in}} = \frac{M}{M_C}$$

- ❑ M should be a power of 2 (to speed up FFT computation)
- ❑ M_C must be integer to avoid spectral leakage
- ❑ M and M_C must be mutually prime: $\gcd(M, M_C) = 1 \Rightarrow$ Make M_C odd



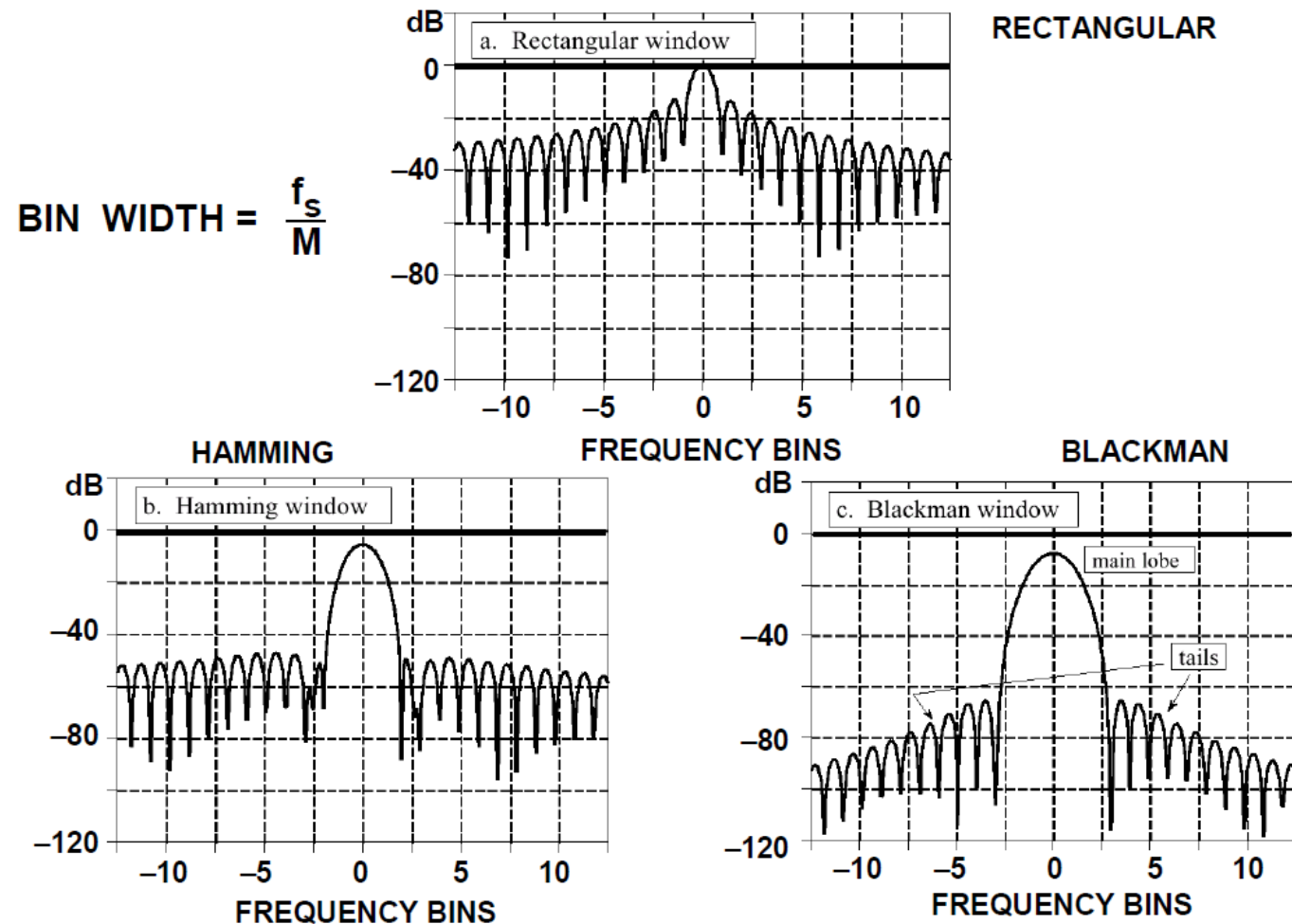
Windowing for Non-Coherent Testing

- Windowing mitigates spectral leakage for arbitrary input tone
 - Coherent testing condition does not have to be strictly satisfied



Window Functions Example (M=256)

- ❑ Multiplication in time domain = Convolution in frequency domain
 - The window is modulated by the tone (frequency shifting)



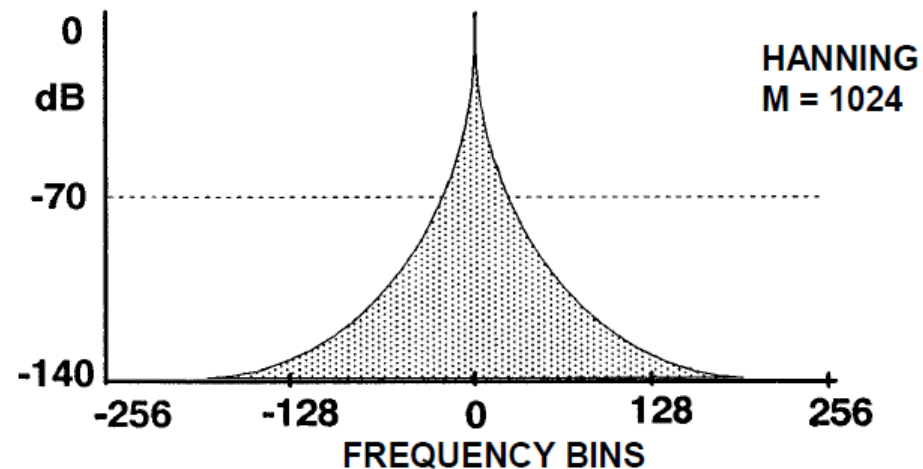
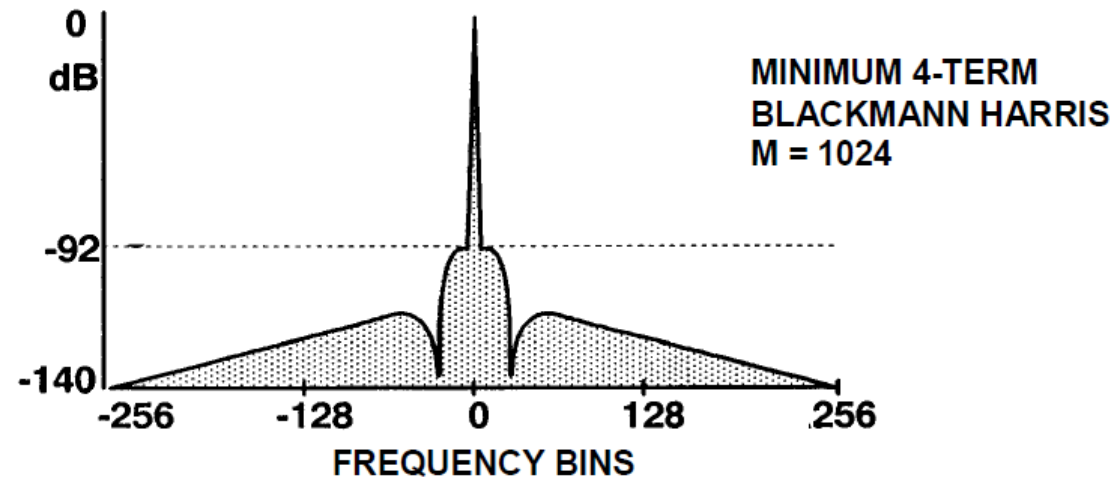
Window Functions Comparison

- ❑ Tradeoff between main-lobe spreading and side-lobe rejection

WINDOW FUNCTION	3dB BW (Bins)	6dB BW (Bins)	HIGHEST SIDELOBE (dB)	SIDELOBE ROLLOFF (dB/Octave)
Rectangle	0.89	1.21	−12	6
Hamming	1.3	1.81	− 43	6
Blackman	1.68	2.35	−58	18
Hanning	1.44	2.00	−32	18
Minimum 4-Term Blackman-Harris	1.90	2.72	−92	6

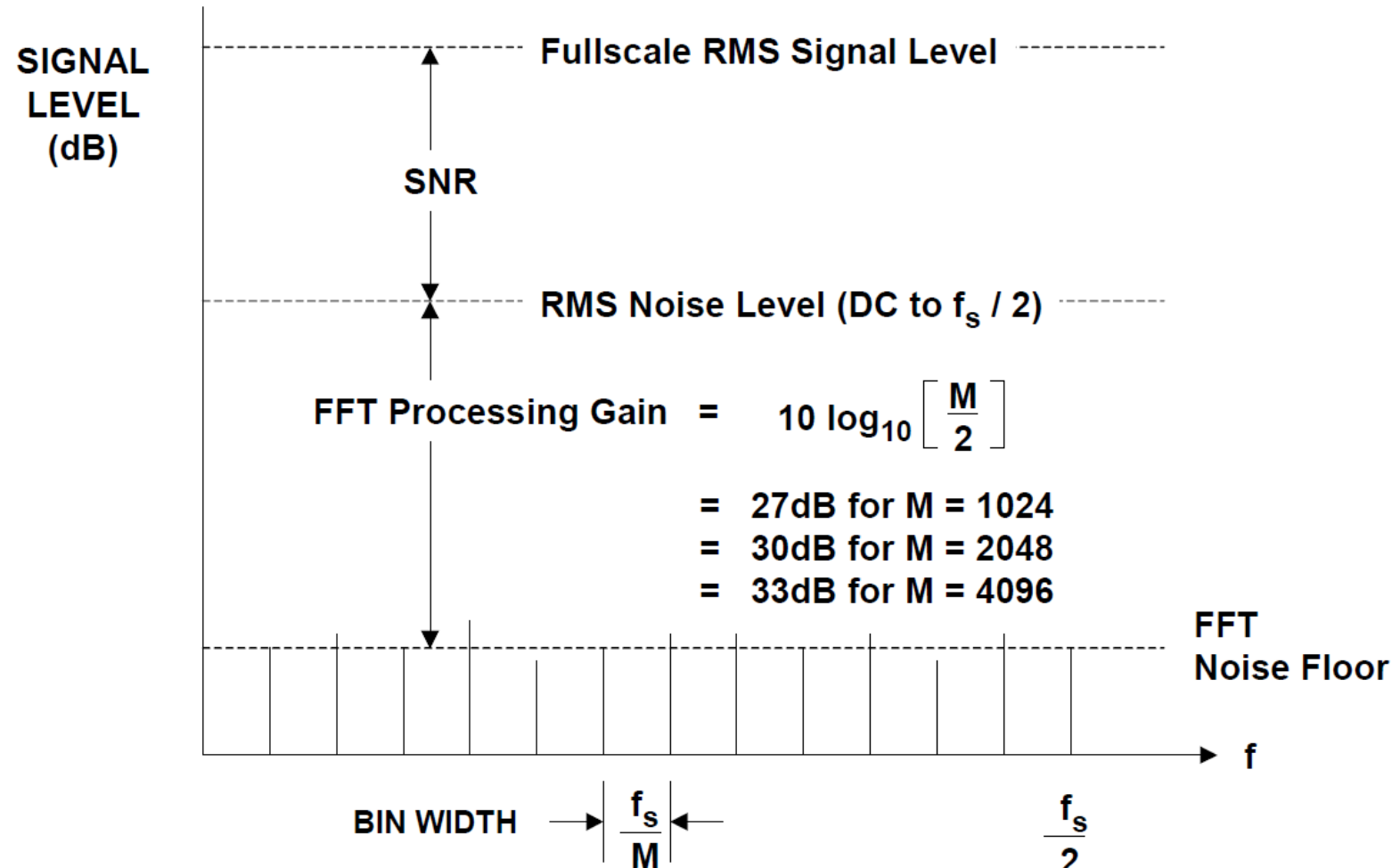
Popular Window Functions

- ❑ Tradeoff between main-lobe spreading and side-lobe rejection



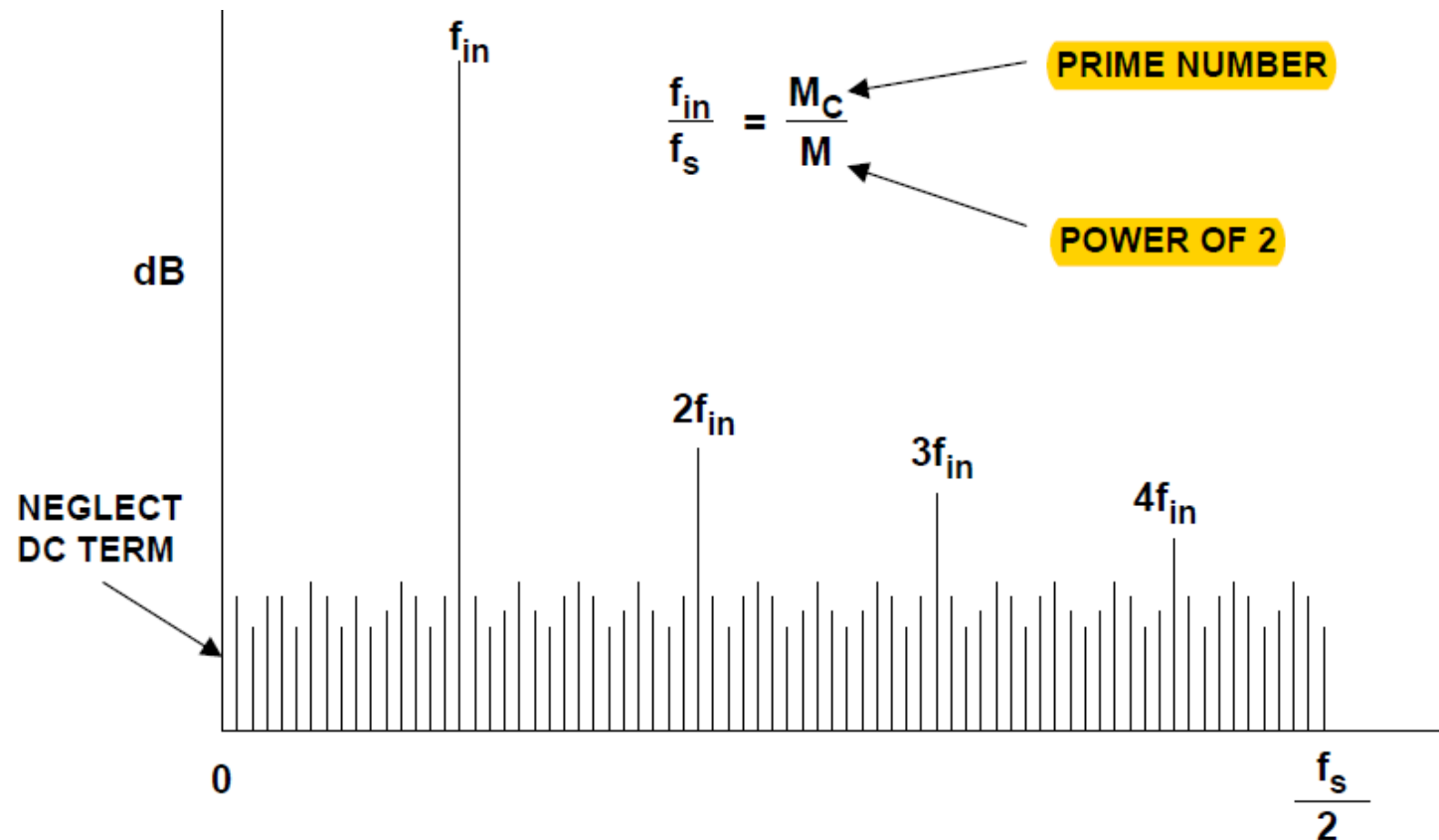
FFT Processing Gain

- Increasing no. of bins (FFT points) reduces noise floor
 - Area = noise power = $M/2 \times \text{Noise Floor}$ = constant



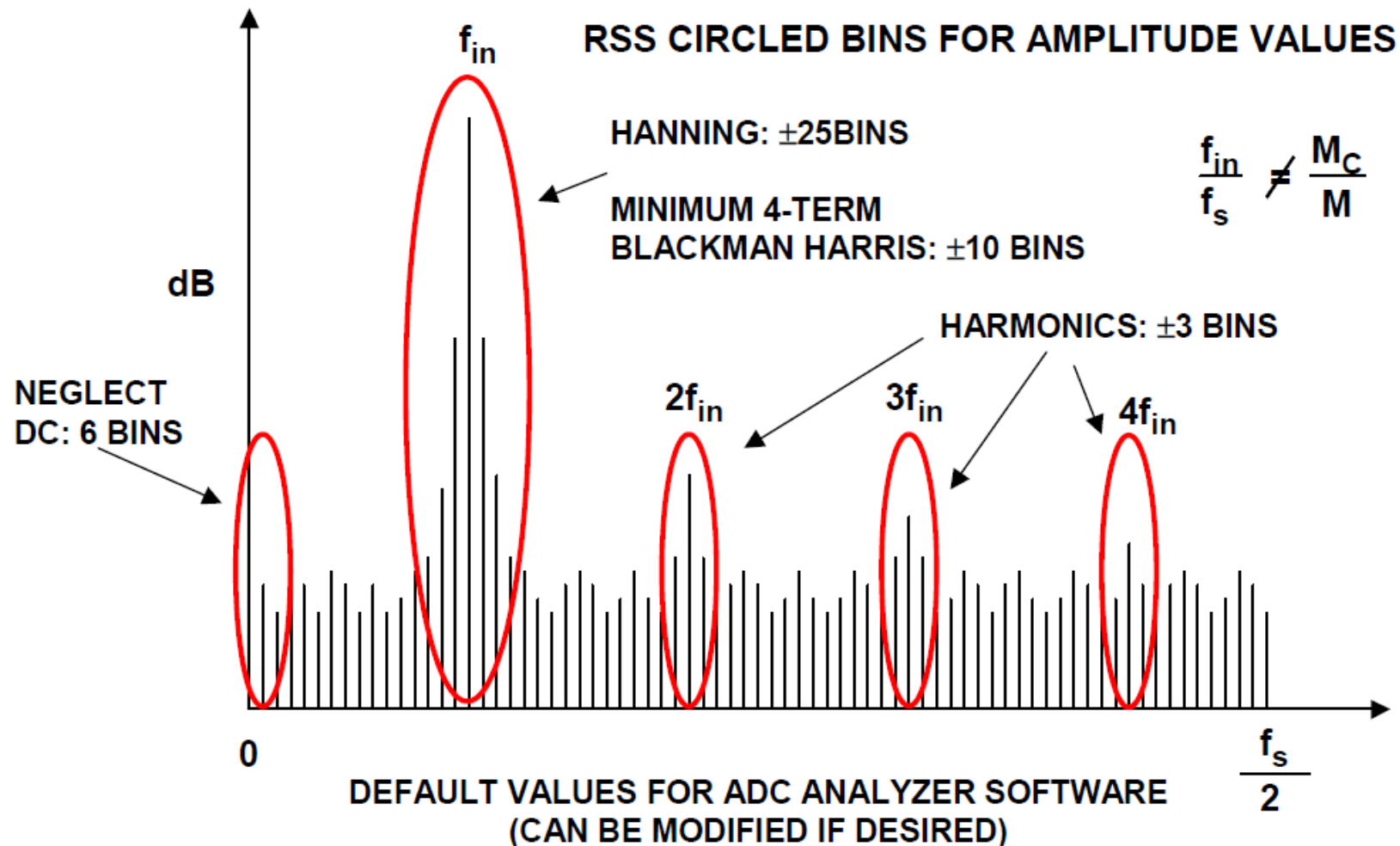
FFT Output for Coherent Testing

- ❑ The fundamental and the harmonics fall in single bins
- ❑ f_s and f_{in} should be generated from locked frequency synthesizers in order to maintain the exact relationship

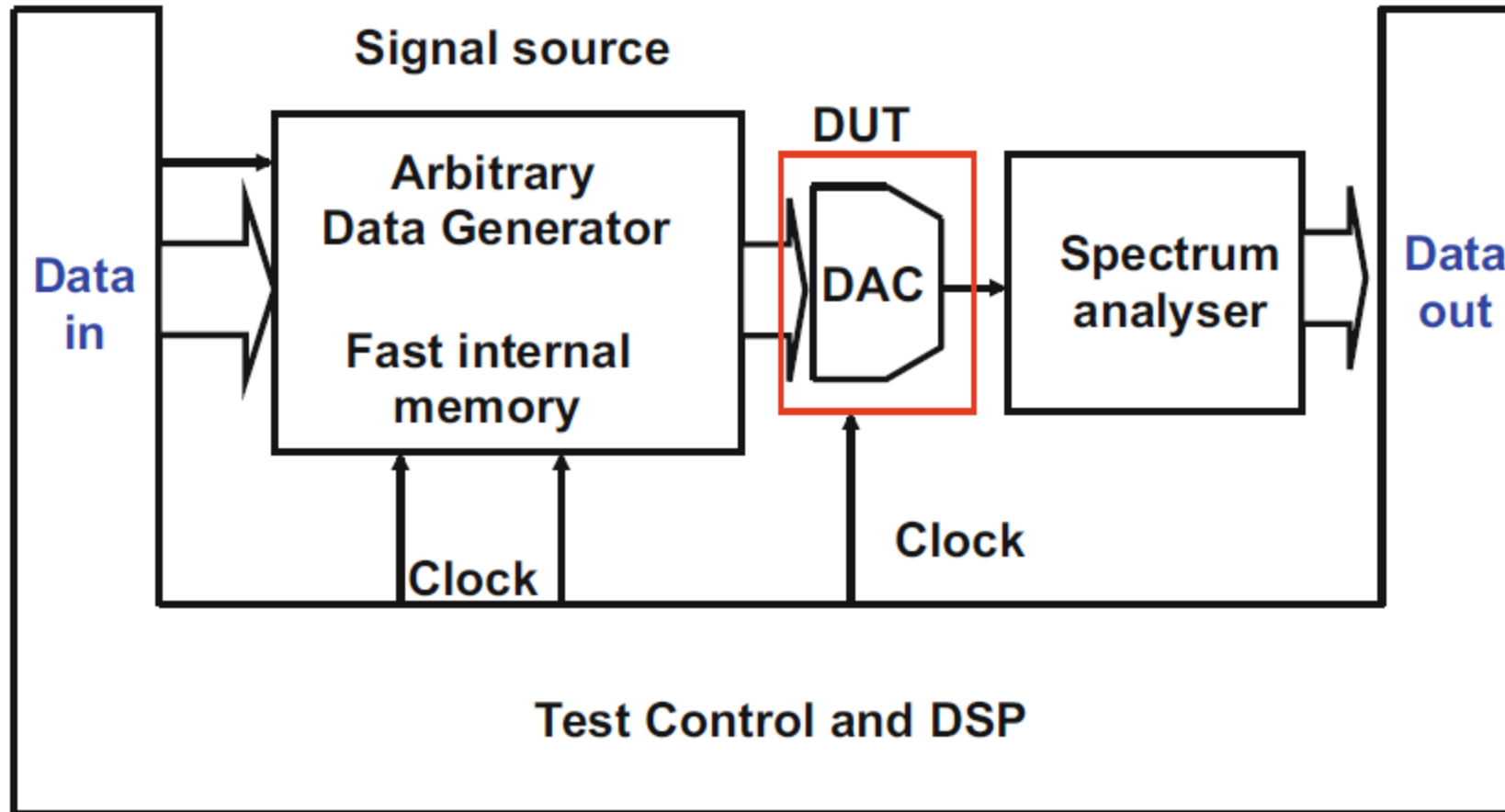


FFT Output for Non-Coherent Testing

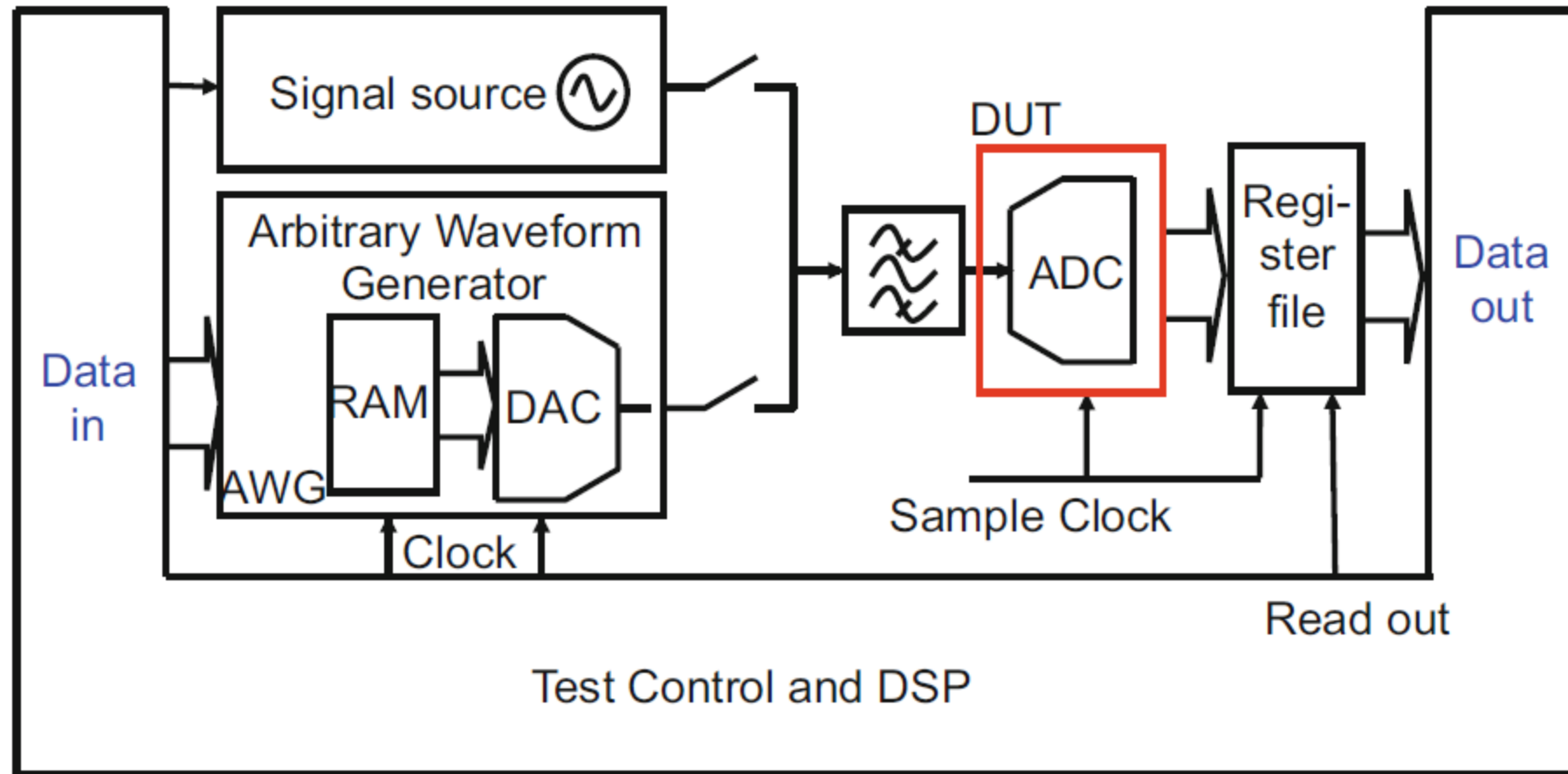
- ❑ Fundamentals and harmonics leak according to the window used
- ❑ Do NOT count leakage bins as noise!



DAC Test Setup

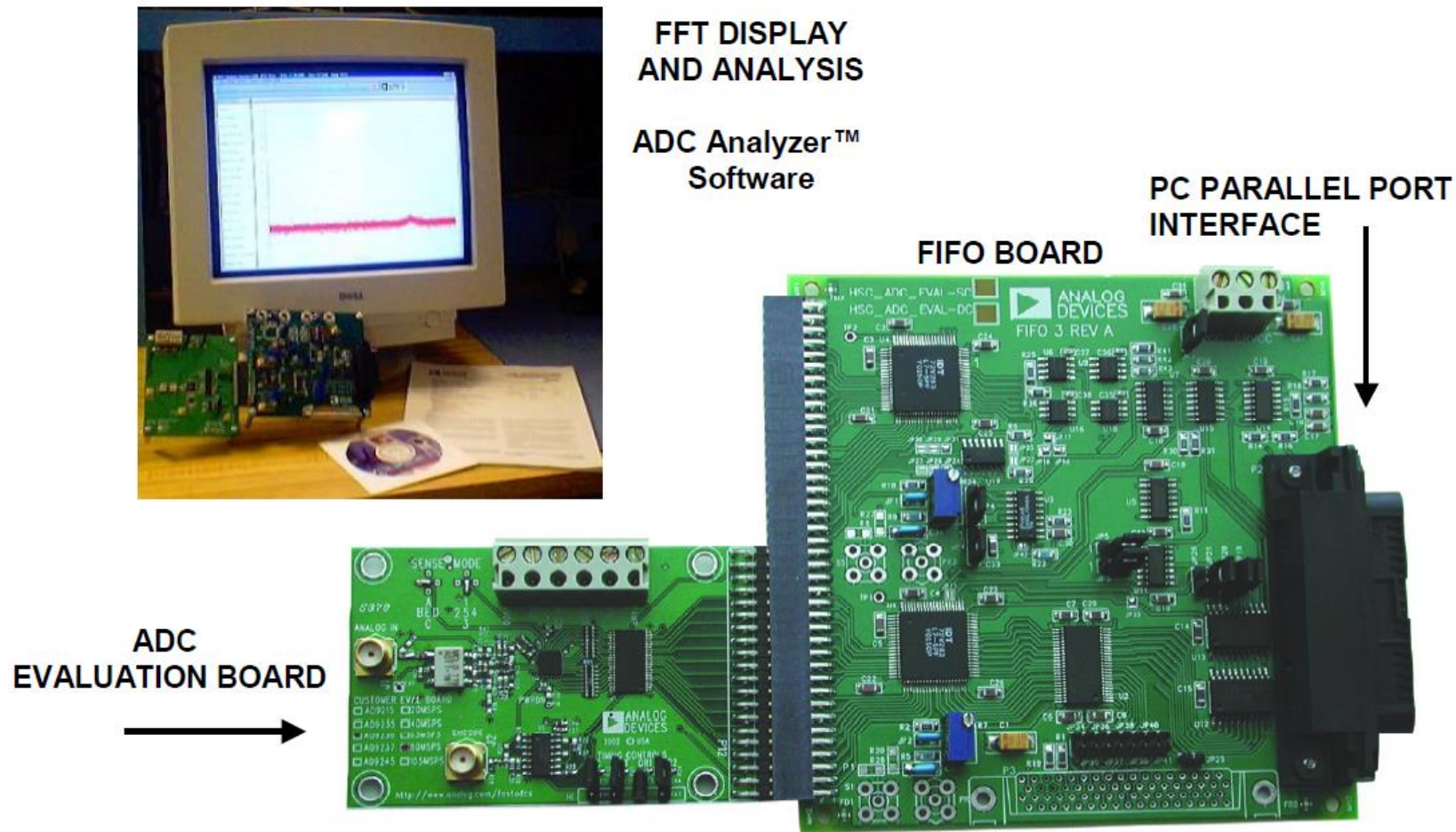


ADC Test Setup Example



Evaluation Boards

- ❑ Evaluation boards and software from manufacturers are very valuable resources.



Test PCB Design Hints

- ☐ **Use (and learn from) manufacturers evaluation boards.**
- ☐ Analog and digital supplies should be separated except at a single node
- ☐ Add decoupling caps at different ranges (Ex: $10\ \mu F$ and $100\ nF$)
- ☐ Add $100\ nF$ cap as close as possible to every supply pin
- ☐ Proper grounding
- ☐ Proper termination of signal with fast rise/fall time
- ☐ For signals with fast rise/fall time every wire is a transmission line

References

- ❑ M. Pelgrom, Analog-to-Digital Conversion, Springer, 3rd ed., 2017.
- ❑ W. Kester, The Data Conversion Handbook, ADI, Newnes, 2005.
- ❑ B. Boser and H. Khorramabadi, EECS 247 (previously EECS 240), Berkeley.
- ❑ B. Murmann, EE 315, Stanford.
- ❑ Y. Chiu, EECT 7327, UTD.

Course Resources

Lectures



Labs



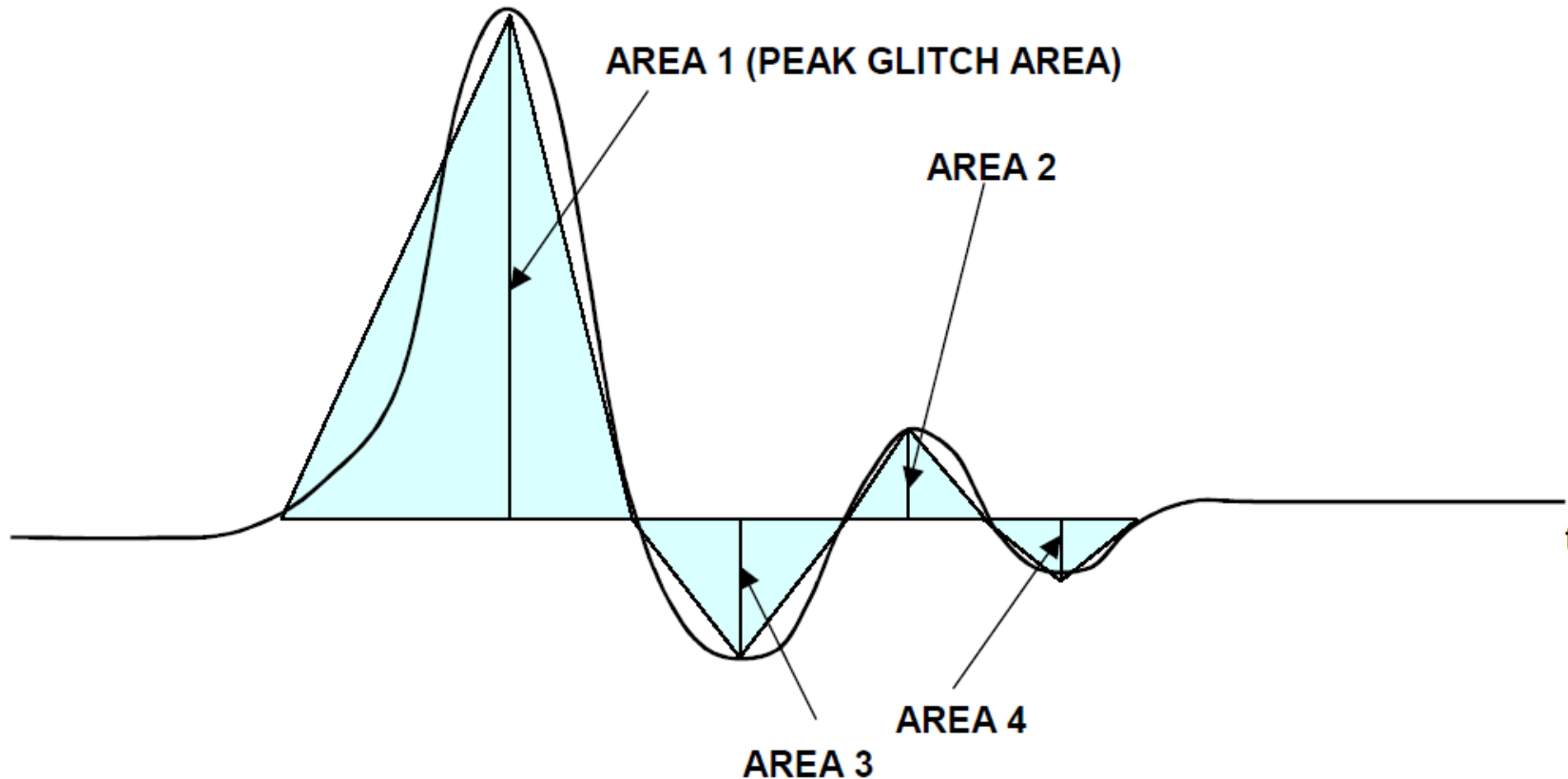
YouTube Channel



Thank you!

DAC Glitch Impulse Area

$$\text{AREA OF TRIANGLE} = \frac{1}{2} \text{ BASE} \times \text{HEIGHT}$$



$$\text{NET GLITCH IMPULSE AREA} \approx \text{AREA 1} + \text{AREA 2} - \text{AREA 3} - \text{AREA 4}$$

Test Setup Example

- ❑ The tool below allows to exchange the samples easily
- ❑ The chip is pushed onto the connection electrodes of the printed-circuit card without socket parasitics

